

Overview

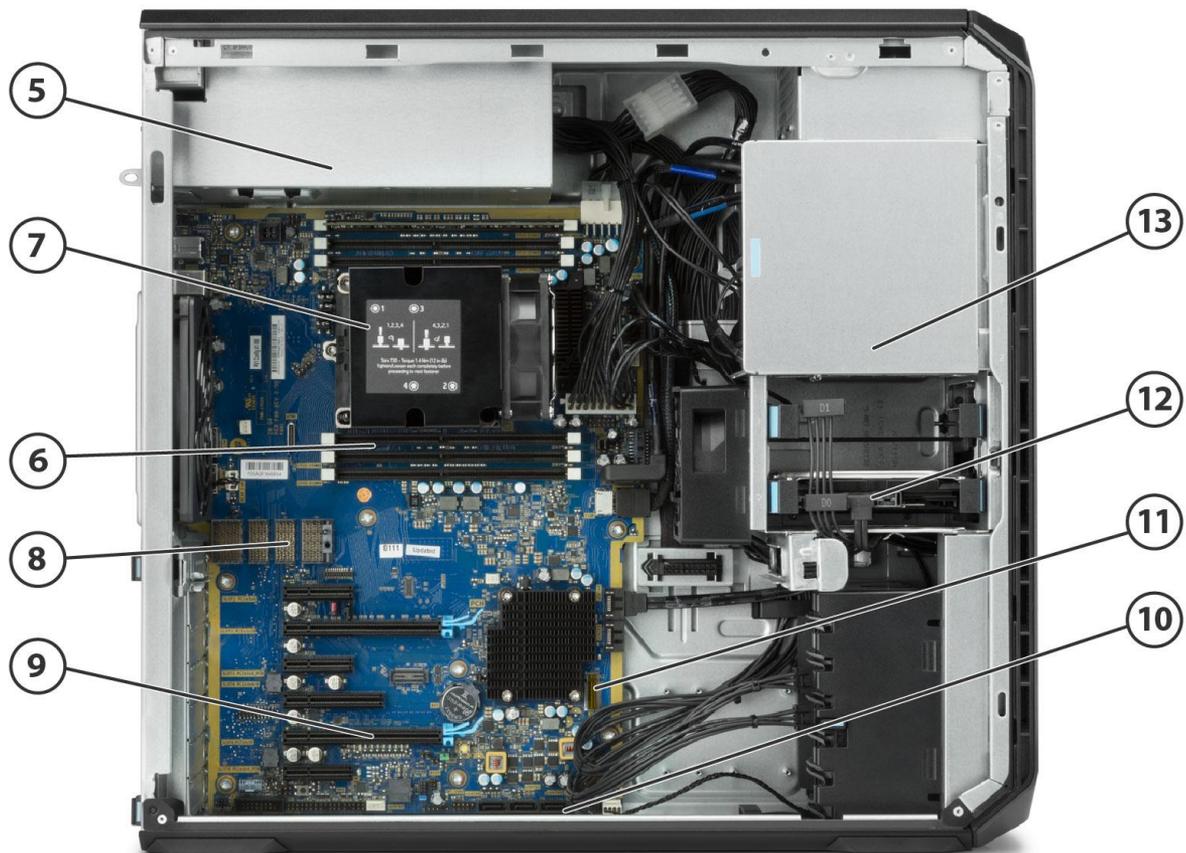
HP Z6 G4 Workstation



Front view

1. Integrated Front Handle
2. Front I/O module options
 - Premium (optional, shown here): power button, 2 USB 3.1 G1 Type-A, 2 USB 3.1 G2 Type-C™ (Left-most Type A port has charging capability), Headset/Mic, Media Card Reader (optional).
 - Standard: power button, 4 USB 3.1 G1 Type-A (left-most Type A port has charging capability), Headset/Mic, Media Card Reader (optional).
3. 2 x 5.25" external bays
4. 1 Slim ODD bay

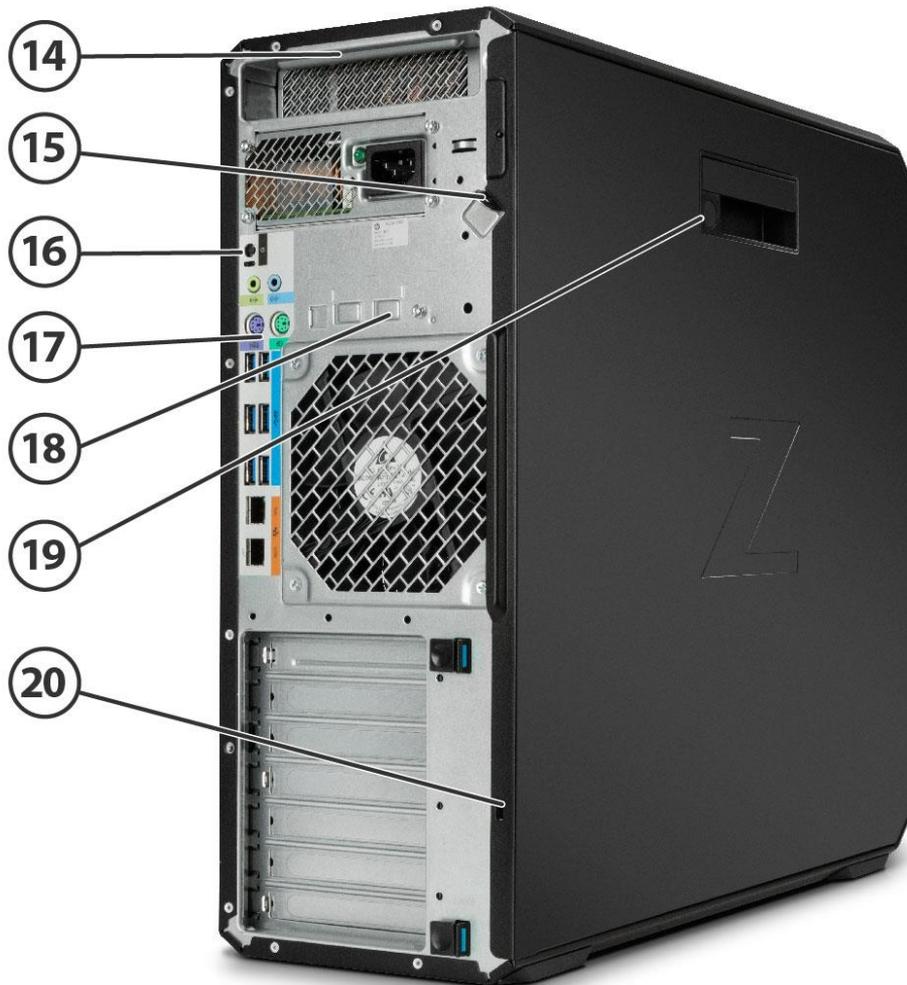
Overview



Internal view

- | | |
|---|---------------------------------------|
| 5. Power supply: 1000W 90% efficient with 2 graphics power adapters | 10. 6 x 6Gb/s SATA ports |
| 6. 6 DIMM slots: DDR4-2666 Registered RAM | 11. 2 PCIe G3 x4 M.2 for SSDs |
| 7. Intel® Xeon® processor Scalable family | 12. 2 x 2.5"/3.5" internal drive bays |
| 8. 2 nd CPU & memory riser connector: adds 2 nd CPU socket and (6) DIMM slots | 13. 2 x 5.25" external drive bays |
| 9. PCIe slots: 2 PCIe G3 x16, 3 PCIe G3 x4, 1 PCIe G3 x8 | |

Overview



Rear view

- | | | | |
|-----|---|-----|---|
| 14. | Rear handle | 18. | HP Dual Port 10GBase-T NIC module slot (optional) |
| 15. | Padlock loop | 19. | Side panel barrel keylock (optional) |
| 16. | Rear power button | 20. | Kensington lock slot |
| 17. | Rear I/O (top to bottom): audio in/out, keyboard/mouse PS/2, 6 USB 3.1 G1 Type-A, 2 x 1GbE LAN ports | | |

Overview

Overview

Form Factor Operating Systems

Tower

Preinstalled:

- Windows 11 Pro for Workstations²
- Windows 10 Pro for Workstations^{1,2}
- Ubuntu 20.04 LTS³
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat® Enterprise Linux® Desktop Workstation (Paper license with 1 year support; no preinstalled OS)

Supported:

- Red Hat Enterprise Linux Workstation 6, 7, 8⁴
- SUSE Linux Enterprise Desktop 12, 15⁴
- Ubuntu 16.04, 18.04, 20.04 LTS³

¹ Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

²Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

³ Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply, and additional requirements may apply over time for updates.

⁴**Notes:** For detailed Linux® OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

NOTE: In accordance with Microsoft's support policy, HP does not support the Windows® 7 operating system on products configured with Intel® 7th Generation and forward processors.

Available Processors

| Name | Cores | Clock Speed (GHz) | Cache (MB) | Memory Speed (MT/s) | Hyper-Threading | Intel® Turbo Boost Technology ¹ | Supports Intel® DCPMM Technology ² | TDP (W) |
|---|-------|-------------------|------------|---------------------|-----------------|--|---|---------|
| Intel® Xeon® W Processors | | | | | | | | |
| Intel® Xeon® W-3265 processor | 24 | 2.7 GHz | 33 | 2933 | Yes | 4.4, 4.6 | NO | 205 |
| Intel® Xeon® W-3245 processor | 16 | 3.2 GHz | 22 | 2933 | YES | 4.4, 4.6 | NO | 205 |
| Intel® Xeon® W-3225 processor | 8 | 3.7 GHz | 16.5 | 2666 | YES | 4.3, 4.4 | NO | 160 |
| Intel® Xeon® W-3223 processor | 8 | 3.5 GHz | 16.5 | 2666 | YES | 4, 4.2 | NO | 160 |
| Intel® Xeon® Scalable Processors | | | | | | | | |
| Intel® Xeon® Gold 6258R processor | 28 | 2.7 GHz | 38.50 | 2933 | YES | 4.0, 3.4 | YES | 205 |

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|-------------------------------------|----|---------|-------|------|-----|----------|-----|-----|
| Intel® Xeon® Gold 6248R processor | 24 | 3.0 GHz | 35.75 | 2933 | YES | 4.0, 3.9 | YES | 205 |
| Intel® Xeon® Gold 6246R processor | 16 | 3.4 GHz | 35.75 | 2933 | YES | 4.1, 4.0 | YES | 205 |
| Intel® Xeon® Gold 6244 processor | 8 | 3.6 GHz | 24.75 | 2933 | YES | 4.3, 4.4 | YES | 150 |
| Intel® Xeon® Gold 6242R processor | 20 | 3.1 GHz | 35.75 | 2933 | YES | 4.1, 3.8 | YES | 205 |
| Intel® Xeon® Gold 6242 processor | 16 | 2.6 GHz | 22 | 2933 | YES | 3.5, 3.9 | YES | 150 |
| Intel® Xeon® Gold 6240 processor | 18 | 2.6 GHz | 24.75 | 2933 | YES | 3.3, 3.9 | YES | 150 |
| Intel® Xeon® Gold 6234 processor | 8 | 3.3 GHz | 24.75 | 2933 | YES | 4.0, 4.0 | YES | 130 |
| Intel® Xeon® Gold 6230R processor | 26 | 2.1 GHz | 35.75 | 2933 | YES | 4.0, 3.0 | YES | 150 |
| Intel® Xeon® Gold 6226R processor | 16 | 2.9 GHz | 22 | 2933 | YES | 3.9, 3.6 | YES | 150 |
| Intel® Xeon® Gold 6226 processor | 12 | 2.7 GHz | 19.25 | 2933 | YES | 3.5, 3.7 | YES | 125 |
| Intel® Xeon® Gold 6136 processor | 12 | 3.0 GHz | 24.75 | 2666 | YES | 3.6, 3.7 | NO | 150 |
| Intel® Xeon® Gold 6128 processor | 6 | 3.4 GHz | 19.25 | 2666 | YES | 3.7, 3.7 | NO | 115 |
| Intel® Xeon® Gold 5222 processor | 4 | 3.8 GHz | 16.5 | 2933 | YES | 3.9, 3.9 | YES | 105 |
| Intel® Xeon® Gold 5220R processor | 24 | 2.2 GHz | 35.75 | 2666 | YES | 4.0, 2.9 | YES | 150 |
| Intel® Xeon® Gold 5218R processor | 20 | 2.1GHz | 27.5 | 2666 | YES | 4.0, 2.9 | YES | 125 |
| Intel® Xeon® Gold 5218 processor | 16 | 2.3 GHz | 22 | 2666 | YES | 2.8, 3.9 | YES | 125 |
| Intel® Xeon® Gold 5118 processor | 12 | 2.3 GHz | 16.50 | 2400 | YES | 2.7, 3.2 | NO | 105 |
| Intel® Xeon® Silver 4216 processor | 16 | 2.1 GHz | 22 | 2400 | YES | 2.7, 3.2 | NO | 100 |
| Intel® Xeon® Silver 4215R processor | 8 | 3.2 GHz | 11 | 2400 | YES | 4.0, 3.6 | YES | 130 |
| Intel® Xeon® Silver 4214R processor | 12 | 2.4 GHz | 16.5 | 2400 | YES | 3.0, 3.5 | NO | 100 |
| Intel® Xeon® Silver 4214 processor | 12 | 2.2 GHz | 16.5 | 2400 | YES | 2.7, 3.2 | NO | 85 |
| Intel® Xeon® Silver 4210R processor | 10 | 2.4 GHz | 13.75 | 2400 | YES | 2.9, 3.2 | NO | 100 |
| Intel® Xeon® Silver 4210 processor | 10 | 2.2 GHz | 13.75 | 2400 | YES | 2.7, 3.2 | NO | 85 |
| Intel® Xeon® Silver 4208 processor | 8 | 2.1 GHz | 11 | 2400 | YES | 2.5, 3.2 | NO | 85 |
| Intel® Xeon® Silver 4114 processor | 10 | 2.2 GHz | 13.75 | 2400 | YES | 2.5, 3.0 | NO | 85 |
| Intel® Xeon® Silver 4108 processor | 8 | 1.8 GHz | 11.00 | 2400 | YES | 2.1, 3.0 | NO | 85 |
| Intel® Xeon® Bronze 3206R processor | 8 | 1.9 GHz | 11.00 | 2133 | YES | N/A | NO | 85 |
| Intel® Xeon® Bronze 3204 processor | 6 | 1.9 GHz | 8.25 | 2133 | YES | N/A | NO | 85 |

Overview

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| | <p>All Z6G4 Intel® Xeon® CPUs Feature Intel® vPro™ Technology.</p> <p>¹The specifications shown in this column represent the following: (all core maximum turbo frequency, one core maximum turbo frequency). Processors that do not have turbo functionality are denoted as N/A.</p> <p>²Intel® Data Center Persistent Memory Modules availability will be announced at a future date.</p> |
|--|---|

Available Processors

Disclaimers

When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families.

Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

Color

Black

Convertibility

No

Expansion Slots (see system board section for more details)

Slot 0:
Mechanical-only, for use with devices that require only rear bulkhead mounting or when 2nd CPU riser is installed

Slot 1:
PCI Express Gen3 x4 - CPU with open-ended connector*

Slot 2:
PCI Express Gen3 x16 - CPU

Slot 3:
PCI Express Gen3 x4 - PCH with open-ended connector*

Slot 4:
PCI Express Gen3 x8 – CPU with open-ended connector (slot converts to x4 electrical when SSD is installed in 2nd M.2 slot)*

Slot 5:
PCI Express Gen3 x16 - CPU

Slot 6:
PCI Express Gen3 x4 - PCH with open-ended connector*

M.2 Slot 1:
M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

M.2 Slot 2:
M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.

Overview

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|--|--|
| Expansion Bays (see storage section for more details) | <p>2 internal 3.5" bays (with acoustic dampening rail assemblies pre-installed)</p> <p>2 external 5.25" bays</p> <ul style="list-style-type: none"> • 3rd and 4th 3.5" HDD each occupy one external bay • 3rd and 4th 2.5" HDD/SSD occupy a single external bay within a 2:1 carrier) <p>1 dedicated 9.5mm slim optical disk drive bay</p> |
| Front I/O | <ul style="list-style-type: none"> • Base: Power button, 1 Headset audio port, 4 USB 3.1 G1 Type A (1 charging) • Premium (optional): Power button, 1 Headset audio port, 2 USB 3.1 G2 Type C™, 2 USB 3.1 G1 Type A (1 charging) • Optional: SD reader |
| Internal I/O | 1 USB 3.1 G1 (aka USB 3.0) single-port header, 1 USB 2.0 single-port header and 1 USB 2.0 dual-port header |
| Rear I/O | 6 USB 3.1 G1 (aka USB 3.0) Type A ports, 2 1Gbe LAN ports (1x supporting Intel® AMT), Audio: 1 Line out, 1 Line in (Line in can be retasked as microphone), 1 PS/2 mouse port, 1 PS/2 keyboard port, 1 Rear power button Optional: 1 serial port (cable up to rear bulkhead) |
| Interfaces Supported | SD card reader (optional) 6-channel SATA interface (6 @ 6.0 Gb/s) 6 channels are eSATA configurable for use with eSATA CTO/AMO Kit (No hot plug / hot swap supported) USB 2.0, USB 3.1 G1 (aka USB 3.0), USB 3.1 G2 (optional) |
| On-board RAID Support | SATA RAID 0 Striped Array SATA RAID 1 Mirrored Array SATA RAID 5 Striped/Parity SATA RAID 10 Striped/Mirrored |
| Chassis Dimensions (H x W x D) | H: 17.5" (445mm) W: 6.65" (169mm) D: 18.3" (465mm) |
| Packaged Dimensions | H: 24" (610mm) W: 12.3" (313mm) D: 23.3" (593mm) |
| Palletization Profile | 6 units x 3 layers = 18 units per pallet 1200x1000x1836mm (pallet included) |
| Rack Dimensions | 4U |
| Weight | Exact weights depend upon configuration (System weight only). Minimum: 13.1 kg (29 lbs.) Standard: 13.6 kg (30.1 lbs.) Maximum: 23.9 kg (52.7 lbs.) |
| Temperature | Operating: 5° to 35°C (40° to 95°F) Non-operating: -40° to 60°C (-40° to 140°F) |
| Humidity | Operating: 10% to 85% relative humidity, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% relative humidity, non-condensing, 35° C maximum wet bulb |

NOTE: Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1° C (1.8° F) per 305 m (1,000 feet) elevation increase

Overview

Maximum Altitude (non-pressurized) Operating: 3,048m (10,000ft)
Non-operating: 9,144m (30,000ft)

NOTE: Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1° C (1.8° F) per 305 m (1,000 feet) elevation increase

Power Supply 1000 watts wide-ranging, active Power Factor Correction, 90% Efficient, with 2X 6-pin graphics power cables (graphics power cables are 6/8-pin convertible)

The Z6 G4 1000W power supply efficiency report can be found at this link:
https://plugloadsolutions.com/psu_reports/HP_D15-1K0P1A_1000W_ECOS%204838_Report.pdf

NOTE: All power cords supplied by HP for Desktop Workstations are between 1.83m and 2.5m (dependent on country localization and platform).

Workstation ISV Certifications See the latest list of certifications at
<http://www8.hp.com/us/en/campaigns/workstations/industries-and-partners.html>

Supported Components

Processors

| | Factory Configured | Option Kit | Option Kit Part Number ¹ | Support Notes |
|--|--------------------|------------|-------------------------------------|---------------|
| Intel® Xeon® W-3200 Series CPU | | | | |
| Intel® Xeon® W-3265 2.7 2933 24C processor | Y | N | | |
| Intel® Xeon® W-3245 3.2 2933 16C processor | Y | N | | |
| Intel® Xeon® W-3225 3.7 2666 8C processor | Y | N | | |
| Intel® Xeon® W-3223 3.5 2666 8C processor | Y | N | | |
| Intel® Xeon® Scalable CPU | | | | |
| Intel® Xeon® Gold 6258R processor | Y | N | | |
| Intel® Xeon® Gold 6248R processor | Y | N | | |
| Intel® Xeon® Gold 6246R processor | Y | N | | |
| Intel® Xeon® Gold 6244 processor | Y | Y | 5YT05AA | 1 |
| Intel® Xeon® Gold 6242R processor | Y | N | | |
| Intel® Xeon® Gold 6242 processor | Y | Y | 5YT04AA | 1 |
| Intel® Xeon® Gold 6240 processor | Y | Y | 5YT02AA | 1 |
| Intel® Xeon® Gold 6234 processor | Y | Y | 5YT00AA | 1 |
| Intel® Xeon® Gold 6230R processor | Y | Y | 9VA87AA | 1 |
| Intel® Xeon® Gold 6226R processor | Y | Y | 9VA85AA | 1 |
| Intel® Xeon® Gold 6226 processor | Y | Y | 5YS98AA | 1 |
| Intel® Xeon® Gold 6136 processor | Y | Y | 1XM39AA | 1 |
| Intel® Xeon® Gold 6128 processor | Y | Y | 1XM44AA | 1 |
| Intel® Xeon® Gold 5222 processor | Y | Y | 5YS97AA | 1 |
| Intel® Xeon® Gold 5220R processor | Y | Y | 8BC99AA/AT | 1 |
| Intel® Xeon® Gold 5218R processor | Y | Y | 9VA83AA | 1 |
| Intel® Xeon® Gold 5218 processor | Y | Y | 5YS95AA | 1 |
| Intel® Xeon® Gold 5118 processor | Y | Y | 1XM45AA | 1 |
| Intel® Xeon® Silver 4216 processor | Y | Y | 5YS93AA | 1 |
| Intel® Xeon® Silver 4215R processor | Y | Y | 9VA81AA | 1 |
| Intel® Xeon® Silver 4214R processor | Y | Y | 8BC96AA/AT | 1 |
| Intel® Xeon® Silver 4214 processor | Y | Y | 5YS91AA | 1 |
| Intel® Xeon® Silver 4210R processor | Y | Y | 8BC95AA | 1 |
| Intel® Xeon® Silver 4210 processor | Y | Y | 5YS90AA | 1 |
| Intel® Xeon® Silver 4208 processor | Y | Y | 5YS89AA | 1 |
| Intel® Xeon® Silver 4114 processor | Y | Y | 1XM49AA | 1 |
| Intel® Xeon® Silver 4108 processor | Y | Y | 1XM51AA | 1 |
| Intel® Xeon® Bronze 3206R processor | Y | Y | 8BC93AA | 1 |
| Intel® Xeon® Bronze 3204 processor | Y | Y | 5YS88AA | 1 |

¹ Options kits available for second processor upgrade.

Disclaimers: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families.

Note 1: Intel® DCPMM® (Data Center Persistent Memory) Supported.

Supported Components

Monitors / Displays

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---|--------------------|------------|------------------------|---------------|
| HP Z Display Z22n G2 | | Y | 1JS05AA | |
| HP Z Display Z23n G2 | | Y | 1JS06AA | |
| HP Z Display Z24i G2 | | Y | 1JS08AA | |
| HP Z Display Z24n G2 | | Y | 1JS09AA | |
| HP Z Display Z24nf G2 | | Y | 1JS07AA | |
| HP Z Display Z27n G2 | | Y | 1JS10AA | |
| HP Z Display Z27s (4K display) | | Y | J3G07AA | |
| Supported by all operating systems available from HP Screen size measured diagonally | | | | |

Storage / Hard Drives

SAS Hard Drives

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|------------|------------------------|---------------|
| SAS Hard Drives for HP Workstations | | | | |
| HP 300GB 15k SAS SFF | Y | Y | L5B74AA | |
| NOTE: SAS controller add-in card required | | | | |

SATA Hard Drives

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|------------|------------------------|---------------|
| SATA (Serial ATA) Hard Drives for HP Workstations | | | | |
| 500GB SATA 7200RPM 6Gb/s 3.5" HDD | Y | Y | LQ036AA | |
| 500GB SATA 7200RPM 6Gb/s OPAL2 SFF 3.5" HDD | Y | Y | D8N29AA | |
| 1TB SATA 7200RPM 3.5" HDD | Y | Y | LQ037AA | |
| 1TB SATA 7200RPM Ent 3.5" HDD | Y | Y | WOR10AA | |
| 2TB SATA 7200RPM HDD | Y | Y | QB576AA | |
| 2TB 7200RPM SATA 3.5in Enterprise | Y | Y | Z2274AA | |
| 4TB SATA 7200RPM Ent 3.5" HDD | Y | Y | K4T76AA | |
| 6TB SATA 7200RPM Ent 3.5" HDD | Y | Y | 3DH90AA | |
| 8TB 7200RPM SATA 3.5in Enterprise | Y | Y | Z2273AA | |

NOTES:

Up to (4) 3.5-inch 7200 rpm SATA drives: 500 GB, 1.0, 2.0, 4.0 TB; maximum system HDD storage: 16.0TB

Supported Components

SATA Solid State Drives

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|------------|------------------------|---------------|
| HP Solid State Drives (SSDs) for Workstations | | | | |
| HP 256GB SATA SSD | Y | Y | A3D26AA | |
| HP 512GB SATA SSD | Y | Y | D8F30AA | |
| HP 1TB SATA SSD | Y | Y | F3C96AA | |
| HP 2TB SATA SSD | Y | Y | Y6P08AA/AT | |
| HP 256GB SATA SED OPAL2 SSD | Y | Y | G7U67AA | |
| HP 512GB SATA SED OPAL2 SSD | Y | Y | N8T26AA | |
| HP 240GB SATA Enterprise SSD | Y | Y | T3U07AA | |
| HP 480GB SATA Enterprise SSD | Y | Y | T3U08AA | |
| HP 960GB 2.5in Enterprise SATA-3 SSD | Y | Y | 1W6P8AA | |
| 1920GB 2.5in Enterprise SATA-3 SSD | Y | Y | 1W6P9AA | |

PCIe Solid State Drives

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|------------|------------------------|---------------|
| PCIe SSDs for HP Workstations | | | | |
| HP Z Turbo Drive 256GB MLC Z4/Z6 G4 SSD Kit | Y | Y | 1PD56AA | 4 |
| HP Z Turbo Drive 512GB MLC Z4/Z6 G4 SSD Kit | Y | Y | 1PD57AA/AT | 4 |
| HP Z Turbo Drive 1TB MLC Z4/Z6 G4 SSD Kit | Y | Y | 1PD58AA | 4 |
| HP Z Turbo Drive 256GB TLC Z4/Z6 G4 SSD Kit | Y | Y | 1PD59AA/AT | |
| HP Z Turbo Drive 512GB TLC Z4/Z6 G4 SSD Kit | Y | Y | 1PD60AA | |
| HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SSD Kit | Y | Y | 1PD61AA | |
| HP Z Turbo Drive 2TB TLC Z4/Z6 G4 SSD Kit | Y | Y | 3KP39AA | |
| HP Z Turbo Drive 256GB Z4/Z6 G4 SED Kit | N | N | EOL | 4 |
| HP Z Turbo Drive 512GB Z4/Z6 G4 SED Kit | N | N | EOL | 4 |
| HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SED Kit | Y | Y | 6YT76AA | |
| HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SED Module | Y | Y | 6YT79AA | |
| HP Z Turbo 2TB SED OPAL2 TLC M.2 Z4/Z6 SSD | Y | Y | 2Y7W6AA | |
| HP 256GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit | Y | Y | 8PE68AA | 3 |
| HP 512GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit | Y | Y | 8PE69AA | 3 |
| HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit | Y | Y | 8PE70AA | 3 |
| HP 256GB M.2 2280 PCIe NVMe TLC SSD Module | N | Y | 8PE62AA | 2 |
| HP 512GB M.2 2280 PCIe NVMe TLC SSD Module | N | Y | 8PE63AA | 2 |
| HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2 Module | N | Y | 8PE64AA | 2 |
| HP 2TB PCIe NVMe TLC M.2 Z4/6 G4 SSD | Y | Y | 35F74AA | |
| HP Z Turbo Drive Dual Pro | | | | |
| HP Z Turbo Drive Dual Pro 256GB TLC SSD | Y | Y | 4YF60AA | 3 |
| HP Z Turbo Drive Dual Pro 512GB TLC SSD | Y | Y | 4YF61AA | 3 |
| HP Z Turbo Drive Dual Pro 1TB TLC SSD | Y | Y | 4YF62AA | 3 |

Supported Components

| | | | | |
|--|---|---|---------|---|
| HP Z Turbo Drive Dual Pro 2TB TLC SSD | Y | Y | 4YF63AA | 3 |
| HP 256GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | Y | Y | 8PE74AA | 3 |
| HP 512GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | Y | Y | 8PE75AA | 3 |
| HP 1TB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | Y | Y | 8PE76AA | 3 |
| HP Z Turbo Drive Quad Pro | | | | |
| HP Z Turbo Drive Quad Pro 2x256GB PCIe TLC SSD | Y | Y | 4YZ38AA | 1 |
| HP Z Turbo Drive Quad Pro 2x512GB PCIe TLC SSD | Y | Y | 4YZ39AA | 1 |
| HP Z Turbo Drive Quad Pro 2x1TB PCIe TLC SSD | Y | Y | 4YZ40AA | 1 |
| HP Z Turbo Drive Quad Pro 2x2TB PCIe TLC SSD | Y | Y | 3KP42AA | |
| HP Z Turbo Drive Quad Pro 256GB SSD module | N | Y | N2N00AA | 2 |
| HP Z Turbo Drive Quad Pro 512GB SSD module | N | Y | N2N01AA | 2 |
| HP Z Turbo Drive Quad Pro 1TB SSD module | N | Y | T9J00AA | 2 |
| HP Z Turbo Drive Quad Pro 2TB SSD module | N | Y | 3KP43AA | |
| Intel® 905p Series SSD (Optane SSD) | | | | |
| Intel® Optane SSD 905p 280GB AiC** | Y | Y | 2SC47AA | |
| Intel® Optane SSD 905p 480GB AiC** | Y | Y | 2SC48AA | |
| Intel® Optane SSD 905p 380GB M.2 SSD Module | Y | Y | 6LA66AA | |

Note 1: Dual M.2 SSD modules plus carrier and heat sink

Note 2: M.2 SSD module only, for Quad Pro or Dual Pro carrier

Note 3: Single M.2 SSD module plus dual carrier and heat sink

Note 4: These M.2 SSD kits and module are End of Life and no longer available.

** PCIe card installed in standard PCIe x4 slot

Hard Drive Controllers

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|------------|------------------------|---------------|
| SAS Controller | | | | |
| MicroSemi SmartHBA2100-4i4e SAS Controller | Y | Y | 1FV90AA | |

Graphics

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes | Supported # of cards |
|--|--------------------|------------|------------------------|---------------|----------------------|
| Graphics Cable Adapters | | | | | |
| HP DisplayPort to VGA Adapter | Y | Y | AS615AA | | |
| HP DisplayPort to HDMI Adapter | Y | Y | K2K92AA | | |
| HP DisplayPort to Dual Link DVI Adapter | Y | Y | NR078AA | | 1 |
| HP DisplayPort to DVI-D Adapter | Y | Y | FH973AA | | 1 |
| HP DisplayPort to DVI-D Adapter (2-pack) | Y | N | | | 1 |
| HP DisplayPort to DVI-D Adapter (4-pack) | Y | N | | | 1 |
| HP DisplayPort to DVI-D Adapter (6-pack) | Y | N | | | 1 |
| NVIDIA® SLI 3-slot Graphics Connector | Y | Y | 2YY85AA | | 1 |

Supported Components

| | | | | |
|--|---|---|------------|---|
| Quadro RTX NVLink High-Bandwidth 3-slotBridge (RTX 8000, RTX 6000) | N | Y | 6FY13AA | 2 |
| Quadro RTX NVLink 3-slotBridge (RTX 5000) | Y | Y | 6FY14AA | 2 |
| NVIDIA NVLink 3 Slot Bridge (RTX A6000, RTX A5000) | Y | Y | 340L3AA | 2 |
| Entry 3D | | | | |
| NVIDIA® Quadro® P620 2GB Graphics | Y | Y | 3ME25AA | 2 |
| NVIDIA® T400 4 GB 3mDP Graphics | Y | Y | 5Z7E0AA/AT | 2 |
| Mid-range 3D | | | | |
| NVIDIA® T1000 4 GB 4mDP Graphics | Y | Y | 20X22AA/AT | 2 |
| NVIDIA® T1000 8 GB 4mDP Graphics | Y | Y | 5Z7D8AA | 2 |
| NVIDIA® Quadro® P1000 4GB Graphics | Y | Y | 1ME01AA | 3 |
| NVIDIA RTX A2000 6 GB 4mDP Graphics | Y | Y | 340L0AA | 3 |
| NVIDIA RTX A2000 12 GB 4mDP Graphics | Y | Y | 5Z7D9AA | 2 |
| AMD Radeon™ Pro WX 3200 4GB Graphics | Y | Y | 6YT68AA | 2 |
| AMD Radeon Pro W6600 8 GB GDDR6 4DP Graphics | Y | Y | 340K5AA | 1 |
| High End 3D | | | | |
| NVIDIA® RTX A4500 20 GB GDDR6 4DP Graphics | Y | Y | 5S458AA/AT | 2 |
| AMD Radeon™ Pro W5500 8GB Graphics | Y | Y | 9GC16AA/AT | 2 |
| AMD Radeon™ Pro W5700 8GB Graphics | Y | Y | 9GC15AA/AT | 1 |
| Ultra High-End 3D | | | | |
| NVIDIA Long-Life RTX A4000E 16 GB 4DP Graphics | N | Y | 6H7J7AA | 1 |
| NVIDIA® RTX A5000 24 GB Graphics | Y | Y | 20X23AA | 2 |
| NVIDIA® RTX A6000 48 GB 4DP Graphics | Y | Y | 2S6U3AA | 1 |
| AMD Radeon Pro W6800 32 GB Graphics | Y | Y | 340K7AA | 1 |
| NVIDIA® Quadro® Sync II | Y | Y | 1WT20AA | |

Memory

| | SL Processor | CL Processor | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------|--------------|--------------------|------------|------------------------|---------------|
| DDR4-2666 ECC Registered DIMMs | | | | | | |
| 8GB (1x8GB) DDR4-2666 ECC Reg Memory | Y | N | Y | Y | 1XD84AA | 1,2 |
| 16GB (1x16GB) DDR4-2666 ECC Reg Memory | Y | N | N | Y | 1XD85AA | 1,2 |
| 32GB (1x32GB) DDR4-2666 ECC Reg Memory | Y | N | N | Y | 1XD86AA | 1,2 |
| DDR4-2933 ECC Registered DIMMs | | | | | | |
| 8GB (1x8GB) DDR4-2933 ECC Reg Memory | Y | Y | Y | Y | 5YZ56AA | 1,2 |
| 16GB (1x16GB) DDR4-2933 ECC Reg Memory | N | Y | N | Y | 5YZ54AA | 1,2 |
| 32GB (1x32GB) DDR4-2933 ECC Reg Memory | N | Y | N | Y | 5YZ55AA | 1,2 |
| 64GB (1x64GB) DDR4-2399 ECC Reg Memory | N | Y | N | Y | 5YZ57AA | 1,2 |

SL Processor: Are processors formerly known as Intel® Skylake that are sold under the model name Intel® Xeon® SP: Platinum 8100, Gold 6100, Gold 5100, Silver 4100 and Bronze 3100 Family

Supported Components

CL Processor: Are processors formerly known as Intel® Cascade Lake that are sold under the model name Intel® Xeon® SP: Platinum 8200, Gold 6200, Gold 5200, Silver 4200 and Bronze 3200 Family

NOTES:

1: For details on the supported memory configurations on the HP Z6 G4 Workstation, please refer to the System Technical Specifications - System Board section of this document.

Each processor supports up to 6 channels of DDR4 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

With single-processor configurations, 6 DIMM slots are available. 6 additional DIMM slots are available with the 2nd CPU & Memory Module.

The CPUs determine the speed at which the memory is clocked. If a 2400MT/s capable CPU is used in the system, the maximum speed the memory will run at is 2400MT/s, regardless of the specified speed of the memory.

The Z6 G4 is designed to work ONLY with DDR4 memory. The system will not work with DDR3 memory.

2: Z6 G4 configurations that include a 2nd CPU require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA). Z6 G4 configurations that include greater than 32GB total system memory require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA).

NOTE: Factory-configured CTO (xxxxxAV) and aftermarket AMO (xxxxxAA, xxxxxAT) HP memory part numbers designated as "2666" may ship with "2933" or "3200" speed memory components. Similarly, HP Memory part numbers designated as "2933" may ship with "3200" speed memory. This does not affect HP part number availability, nor does it affect system performance or operation. All hardware configurations currently supporting HP memory part numbers designated as "2666" or 2933 have been fully qualified to work with fast speed memory and are fully supported by HP under standard support terms.

NVDIMM Memory

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|---------------------------|-------------------|-------------------------------|----------------------|
| Intel® Optane™ DC Persistent Memory (DCPMM) | | | | |
| 128GB (1x128GB) DC Persistent Memory Module | Y | Y | 9NH78AA | 1 |
| 256GB (2x128GB) DC Persistent Memory Configuration | Y | N | | 1 |
| 512GB (4x128GB) DC Persistent Memory Configuration | Y | N | | 1,2 |

NOTE 1: Supported only with Xeon 82xx, 62xx, 52xx and 4215/4215R processors.

- a. Available as factory configured in Memory Mode or Storage Mode.
- b. Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT/s.
- c. Operating System Support:
 - i. Windows 11 Pro for Workstations with all updates applied
 - ii. Windows 10 Pro for Workstations v1903 or later with all updates applied.
 - iii. Linux OS support may be found in the [Linux Hardware Support Matrix](#).
- d. Detailed setup, security and support information may be found in the [Intel® Optane™ DC Persistent Memory: Configuration and Setup on HP Z6 G4 and Z8 G4 Workstation](#) white paper.
- e. DCPMM solutions require additional DRAM memory to be included in the solution:
 - i. Systems configured with DCPMM in Memory Mode will include DRAM memory to be used as cache. The amount of included DRAM memory is based on an 8:1 DCPMM to DRAM capacity ratio.
 - ii. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be ordered separately.
 - iii. DCPMM Memory will report approximately 2% less than advertised capacity .
- f. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor system.
 - i. When configured in memory mode, additional DRAM does not count against maximum processor memory.

Supported Components

- g. Maximum number of DCPMM modules in a Z6G4 is 4 per processor.
- h. Customer is responsible for additional required DRAM when adding DCPMM modules in Memory Mode.
- i. HP Z6G4 configured with some AMD Graphics are limited to 1TB of total DCPMM and DRAM memory. See AMD Graphics specifications for details.

NOTE 2: Requires 2nd processor option.

Multimedia and Audio Devices

Supported Components

Multimedia and Audio Devices

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|------------------------------------|--------------------|------------|------------------------|---------------|
| Integrated Realtek HD ALC221 Audio | Y | N | | |

Optical and Removable Storage

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---|--------------------|------------|------------------------|---------------|
| HP SlimTray Optical Drives | | | | |
| HP 9.5mm Slim Blu Ray Disc Writer | Y | Y | K3R65AA | 1 |
| HP 9.5mm Slim DVD ROM | Y | Y | K3R63AA | 1 |
| HP 9.5mm Slim DVD Writer | Y | Y | K3R64AA | 1 |
| HP Half Height Optical Drives | | | | |
| HP HH DVD Writer (16X RW DVD-R) | N | Y | 4AR67AA | |
| HP SD Card Reader | | | | |
| HP SD 4 Card Reader | Y | Y | Y0L99AA | |
| HDD Frame/Carriers | | | | |
| HP DX175 Removable HDD Carrier | N | Y | 1ZX72AA | |
| HP DX175 Removable HDD Frame/Carrier | N | Y | 1ZX71AA | |
| NVMe Frame/Carrier | | | | |
| HP QX310 Removable NVMe Frame/Carrier w/PCIe card | Y | N | 8GQ89AA/AT | |
| HP QX310 Removable Carrier only | N | Y | 8GQ91AA/AT | |

NOTE 1: Installing an optical drive into Z6 G4 requires a 5.25" external bay adapter 746536-001 which is included in the ODD kit.

Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Networking and Communications

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|------------|------------------------|---------------|
| NVIDIA® Mellanox® ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC | Y | Y | 436M8AA | 1 |
| HP 10GbE SFP+ SR/SW LC Fiber Optic Transceiver | N | Y | 860T8AA | |
| HP 25GbE SFP28 LC Fiber Optic Transceiver | N | Y | 860T9AA | |

Supported Components

| | | | | |
|--|---|---|------------|---|
| HP i350-T2 PCIe Dual Port Gigabit NIC | Y | Y | V4A91AA | |
| Intel® i350-T4 PCIe 4-Port Gigabit NIC | N | Y | W8X25AA | |
| Intel® Ethernet I210-T1 PCIe x1 Gb NIC | Y | Y | E0X95AA | |
| Aquantia® NBASE-T 5GbE PCIe NIC | N | Y | 1PM63AA | |
| HP Dual Port 10GBase-T NIC Module | Y | Y | 1QL49AA | |
| Intel® 8265 802.11 a/b/g/n/ac + BT PCIe WLAN | N | Y | 1QL48AA | |
| Intel® X550-T2 10GbE Dual Port NIC | Y | Y | 1QL46AA | |
| Intel® X710-DA2 10GbE SFP+ Dual Port NIC | Y | Y | 1QL47AA | 2 |
| HP 10GbE SFP+ SR 1 st Transceiver | Y | Y | C3N53AA | |
| HP 10GbE SFP+ SR 2 nd Transceiver | Y | Y | C3N53AA | |
| Intel® Wi-Fi 6 AX200 & BT PCIe | N | Y | 7CE01AA | 2 |
| Intel AX210 Wi-Fi 6e non-vPro +Bluetooth 5.2 External Antenna WLAN | N | Y | 340L7AA | |
| Allied Telesis AT-2914SX/LC-901 1GB LC Fiber NIC | Y | Y | 1C7Q2AA | |
| Allied Telesis AT-2911T/2-901 Dual Port 1GbE NIC | Y | Y | 6E3Y9AA/AT | |

Note 1: Transceivers sold separately. You must have a transceiver installed in order to connect this card to a network.

Note 2: Windows 7 is NOT supported

Racking and Physical Security

Supported Components

Racking and Physical Security

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|------------|------------------------|---------------|
| HP Z4/Z6 Side Panel Barrel Keylock | Y | N | | |
| HP Solenoid Lock / Hood Sensor | Y | N | | |
| HP Z4/Z6 Depth Adjustable Fixed Rail Rack Kit | N | Y | 2HW42AA | |
| HP Z2 Mini/Z2 TWR/Z4/Z6 Dept Adj Fixed Rail Rack Kit | | Y | 2A8Y5AA | |
| HP Keyed Cable Lock 10mm | N | Y | T1A62AA | |

Input Devices

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|--------------------|------------|------------------------|---------------|
| HP Wireless Business Slim Keyboard and Mouse | Y | Y | N3R88AA | |
| Business Slim PS/2 Wired Keyboard | Y | Y | N3R86AA | |
| USB Business Slim Wired Keyboard | Y | Y | N3R87AA | |
| USB Premium Wired Keyboard | Y | Y | Z9N40AA | |
| USB Wired SmartCard CCID Keyboard | Y | Y | E6D77AA | |
| HP 320K Wired Keyboard | Y | Y | 9SR37AA | |
| HP Optical USB Mouse | Y | Y | QY777AA | |
| HP PS/2 Mouse | Y | Y | QY775AA | |
| HP USB Hardened Mouse | Y | Y | P1N77AA | |
| HP Creator 935 Black Wireless Mouse | N | Y | 1D0K8AA | |
| HP Wired 320M Mouse | Y | Y | 9VA80AA | |

Other Hardware

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---|--------------------|------------|------------------------|---------------|
| HP ENERGY STAR® Certified Configuration | Y | | | |
| HP Z Premium Front I/O 2xUSB-A 2xUSB-C | Y | Y | 1XM32AA | |
| HP Z6 G4 Memory Cooling Solution | Y | Y | 2HW44AA | Note 1 |
| HP Internal USB Port Kit | N | Y | EM165AA | Note 2 |
| HP eSATA 2 port PCI Bulkhead Kit | Y | Y | GM110AA | |
| HP Workstation Mouse Pad | Y | | | |
| HP Anyware Remote System Controller | N | Y | 7K6D7AA | Note 3 |
| HP Anyware Remote System Controller Main Board Adapter | N | Y | 7K6D8AA | |
| HP Anyware Integrated Remote System Controller | N | Y | 7K6D9AA | Note 3 |
| HP Z4/Z6/Z8 G4 / ZCentral 4R Remote System Controller Cable Adapter | N | Y | 7K6E5AA | Note 4 |
| HP Anyware Remote System Controller for Universal KVM | N | Y | 7K7N2AA | |

Supported Components

Note 1: Z6 G4 configurations that include a 2nd CPU require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA). Z6 G4 configurations that include greater than 32GB total system memory require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA).

Note 2: The HP Internal USB Port kit has a single USB 2.0 type A connector.

Note 3: Requires additional purchase of 7K6E5AA HP Z4/Z6/Z8 G4 / ZCentral 4R Remote System Controller Cable Adapter.

Note 4: By installing the HP Z4/Z6/Z8 G4 / ZCentral 4R Remote System Controller Cable Adapter (7K6E5AA), power will be stolen from the front USB ports on the host. This was necessary to be able to power the Remote System Controllers in all power states, and it leaves the front USB ports unpowered and unusable.

Application Software

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--------------------------------|--------------------|------------|------------------------|---------------|
| Sobey Video Editing SW | Y | N | | |
| HP ZCentral Remote Boost | N | N | | |
| Data Science Stack | Y | N | | 1, 2 |
| WSL2/Ubuntu Data Science Stack | Y | N | | 1, 3 |

*Not all Application Software for Z Desktop Workstations is included with purchase.

Note 1: Only available with NVIDIA graphics cards selections.

Note 2: Only available with Ubuntu 20.04 LTS preinstall.

Note 3: Only available with Windows 10 Pro for Workstations or Windows 11 Pro for Workstations.

Supported Components

Operating Systems

| | Support Notes |
|---|---------------|
| Windows 11 Pro for Workstations | Note 4,1 |
| Windows 10 Pro for Workstations | Note 3,4,1 |
| Ubuntu 20.04 LTS | Note 2 |
| HP Linux® Installer Kit | Note 2 |
| Red Hat® Enterprise Linux® (RHEL) Workstation - Paper License (1yr) | Note 2,5 |

NOTE 1: Available with Windows Subsystem for Linux® (WSL2).

NOTE 2: For detailed Linux® OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

NOTE 3: Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

NOTE 4: Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

NOTE 5: This second OS must be ordered with the HP Linux® Installer Kit as the first OS.

System Technical Specifications

System Board

System Board Form Factor Main System Board:
24 x 31 cm
9.6 x 12.2 inches

2nd CPU/Memory Board (optional):
14.9 x 29.2 cm
5.85 x 11.50 inches

Processor Socket FCLGA3647 (Socket P)
1st CPU on system board
2nd CPU on optional 2nd CPU/Memory Module

CPU Bus Speed UPI: Up to 10.4GT/second, depending on processor

Chipset Intel® C622 Chipset

Super I/O Controller Nuvoton SIO15

Memory Expansion Slots 6 on system board (CPU0) + 6 on optional 2nd CPU/Memory Module (CPU1)

Memory Type Supported DDR4 R-DIMM (Registered), ECC: 8GB, 16GB, 32GB, and 64GB

Memory Modes NUMA (Non-Uniform Memory Architecture), Memory Node Interleave

Memory Speed Supported 2133MT/s, 2400MHz, 2666MT/s, and 2933MT/s

Available Memory Configurations:

| Single Processor | | | | | | | |
|------------------|-------|-------|-------|--------------|-------|-------|-------------|
| CPU 0 | | | | | | | |
| Top Slots | | | | Bottom Slots | | | Perf Rating |
| Capacity | DIMM1 | DIMM2 | DIMM3 | DIMM4 | DIMM5 | DIMM6 | |
| 8 GB | 8 GB | | | | | | Fair |
| 16 GB | 8 GB | | | | | 8 GB | Good |
| 24 GB | 8 GB | 8 GB | 8 GB | | | | Better |
| 32 GB | 8 GB | | 8 GB | 8 GB | | 8 GB | Better |
| | 16 GB | | | | | 16 GB | Good |
| 48 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | Best |
| | 16 GB | 16 GB | 16 GB | | | | Better |
| 64 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | Better |
| | 32 GB | | | | | 32 GB | Good |
| 96 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | Best |
| | 32 GB | 32 GB | 32 GB | | | | Better |
| 128 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | Better |
| 192 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | Best |
| 256 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | Better |
| 384 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | Best |

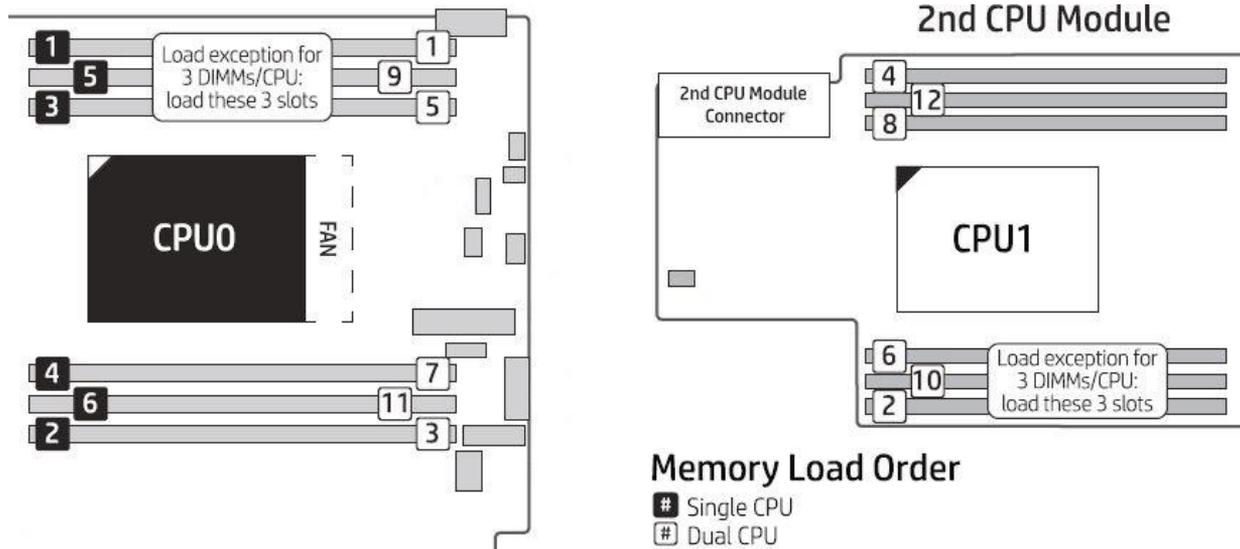
System Technical Specifications

| Dual Processor | | | | | | | | | | | | | | Rating |
|----------------|--------|--------|--------------|--------|--------|--------|-----------|--------|--------|--------------|--------|--------|--------|--------|
| CPU 0 | | | | | | | CPU 1 | | | | | | | |
| Top Slots | | | Bottom Slots | | | | Top Slots | | | Bottom Slots | | | | |
| Capacity | DIMM 1 | DIMM 2 | DIMM 3 | DIMM 4 | DIMM 5 | DIMM 6 | DIMM 1 | DIMM 2 | DIMM 3 | DIMM 4 | DIMM 5 | DIMM 6 | | |
| 16 GB | 8 GB | | | | | | 8 GB | | | | | | Fair | |
| 32 GB | 8 GB | | | | | 8 GB | 8 GB | | | | | 8 GB | Good | |
| 48 GB | 8 GB | 8 GB | 8 GB | | | | 8 GB | 8 GB | 8 GB | | | | Better | |
| 64 GB | 8 GB | | 8 GB | 8 GB | | 8 GB | 8 GB | | 8 GB | 8 GB | | 8 GB | Better | |
| | 16 GB | | | | | 16 GB | 16 GB | | | | | 16 GB | Good | |
| 96 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | Best | |
| | 16 GB | 16 GB | 16 GB | | | | 16 GB | 16 GB | 16 GB | | | | Better | |
| 128 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | Better | |
| | 32 GB | | | | | 32 GB | 32 GB | | | | | 32 GB | Good | |
| 192 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | Best | |
| | 32 GB | 32 GB | 32 GB | | | | 32 GB | 32 GB | 32 GB | | | | Better | |
| 256 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | Better | |
| | 64 GB | | | | | 64 GB | 64 GB | | | | | 64 GB | Best | |
| 384 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | Better | |
| | 64 GB | 64 GB | 64 GB | | | | 64 GB | 64 GB | 64 GB | | | | Best | |
| 512 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | Fair | |
| 768 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | Good | |

System Technical Specifications

Memory Loading Order:

Load Order for Single and Dual Processor Configuration



Maximum Memory Supports up to 768 GB DDR4-2933 ECC RAM* (transfer rates up to 2933MT/s) and 384 GB DDR4-2666 ECC RAM (transfer rates up to 2666MT/s).

- Memory Configuration (Supported)**
- Only Registered ECC DIMMs are supported.
 - Do not install memory modules into memory slots if corresponding processor is not installed.
 - Dual processor configurations with memory modules installed for only one processor is not supported.

Notes For systems installed with Microsoft Windows 7 (Ultimate, Enterprise or Pro), the maximum accessible system memory is 192GB

*768 GB configuration requires 2 CPUs configuration.

NVDIMM Memory Intel® Optane™ DC Persistent Memory is available factory configured in the following capacities:

- 128GB (1x128GB) Single Processor Configuration
- 256GB (2x128GB) Single Processor Configuration
- 512GB (4x128GB) Dual Processor Configuration

NOTES:

- Supported only with Xeon 82xx, 62xx, 52xx and 4215/4215R processors.
- Available as factory configured in Memory Mode or Storage Mode.
- Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT/s.
- Operating System Support:
 - Windows 11 Pro for Workstations with all updates applied.
 - Windows 10 Pro for Workstations v1903 or later with all updates applied.
 - Linux OS support may be found in the [Linux Hardware Support Matrix](#).
- Detailed setup, security and support information may be found in the [Intel® Optane™ DC Persistent Memory: Configuration and Setup on HP Z6 G4 and Z8 G4 Workstation](#) white paper.
- DCPMM solutions require additional DRAM memory to be included in the solution:

System Technical Specifications

- i. Systems configured with DCPMM in Memory Mode will include DRAM memory to be used as cache. The amount of included DRAM memory is based on an 8:1 DCPMM to DRAM capacity ratio.
- ii. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be ordered separately.
- iii. DCPMM Memory will report approximately 2% less than advertised capacity .
- g. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor system.
 - i. When Configured in Memory Mode, additional DRAM does not count against maximum processor memory.
 - ii. Maximum number of DCPMM modules in a Z6G4 is 4 per processor.
- h. Customer is responsible for additional required DRAM when adding DCPMM modules in Memory Mode.
- i. HP Z6G4 configured with some AMD Graphics are limited to 1TB of total DCPMM and DRAM memory. See AMD Graphics specifications for details.

PCI Express Connectors Slot 0:

Mechanical-only, for use with devices that require only rear bulkhead mounting or when 2nd CPU riser is installed

Slot 1:

PCI Express Gen3 x4 - CPU with open-ended connector*

Slot 2:

PCI Express Gen3 x16 - CPU

Slot 3:

PCI Express Gen3 x4 - PCH with open-ended connector*

Slot 4:

PCI Express Gen3 x8 – CPU with open-ended connector (slot converts to x4 electrical when SSD is installed in 2nd M.2 slot)*

Slot 5:

PCI Express Gen3 x16 - CPU

Slot 6:

PCI Express Gen3 x4 - PCH with open-ended connector*

M.2 Slot 1:

M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

M.2 Slot 2:

M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.

Supported Drive Interfaces

SATA 6 SATA @6Gb/s, supports RAID 0, 1, 5, & 10

Serial Attached SCSI Requires Optional PCIe card

Factory Configured RAID SATA RAID 0 Striped Array
SATA RAID 1 Mirrored Array
SATA RAID 10 Striped/Mirrored

System Technical Specifications

Notes:

Factory integrated Intel® SATA RAID is Microsoft Windows only.

External SATA (eSATA) Supported on all SATA ports configurable with optional eSATA* cable kit
* hot plug / hot swap not supported with eSATA

Network Controller **Integrated Intel® I219LM GbE LAN** Supports the following management functionalities: Intel® AMT11.2, TXT, DASH 1.1, WOL, VLAN, and PXE 2.1

Integrated Intel X722 for 1GbE Data rates supported: 1000 Mb/s
Compliance IEEE 802.1as/1588v2, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3x
Up to 16 UDP/TCP programmable filters
Bus architecture: PCIe 3.0
UEFI and PXE Boot ROM support
Intel iWARP Support (RDMA)
Network transfer rates:
1000BASE-T (full-duplex) 2000 Mb/s
Management capabilities: WOL (Excluding Max Power Savings), auto MDI crossover, PXE, Quad Hash filtering, RSS, Advanced cable diagnostics

USB Connector(s) **Front** Front I/O Entry: 4 USB 3.1 Gen1 (Left-most Port has Charging Capability)
Front I/O Premium: 2x USB 3.1 Gen1, 2x USB 3.1 Gen2 Type-C™ (Left-most Port has Charging Capability)

- Charging Ports provide 1.5 Amps @ 5 Volts
- Standard USB Type A Ports provide 900mA @ 5 Volts
- USB Type C Ports provide 3 Amps @ 5 Volts and adhere to the Power Delivery 3.0 specification.

Rear 6 USB 3.1 G1 Type A

Internal 1 USB 3.1 G1 single-port header
1 USB 2.0 single-port header
1x USB 2.0 dual-port header

Integrated Graphics No

HD Integrated Audio Realtek ALC221

Flash ROM Yes

CPU Fan Header One for each CPU socket

Rear Chassis Fan Header Yes

Front PCI Fan Header Yes

CMOS Battery Holder - Lithium Yes

Integrated Trusted Platform Module Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670)
Common Criteria EAL4+ Certified
FIPS 140-2 Certified (firmware v7.85)
TPM Certified products list:
<https://trustedcomputinggroup.org/membership/certification/tpm-certifiedproducts/>

Power Supply Headers Yes

Power Switch, Power LED & Hard Drive LED Header Yes

System Technical Specifications

| | |
|------------------------------|-----------------------------|
| Clear Password Jumper | Yes |
| Serial Port | 1 internal header |
| Parallel Port | No |
| Keyboard/Mouse | USB or PS/2 |
| Hood Lock Header | Yes |
| Hood Sensor Header | Yes |
| Memory Fan | 1 Memory Fan Header per CPU |
| AUX IN (audio) | No |

Z6 Required Power Supply Info

| | | |
|--|--|---------------|
| Power Supply | 1000W 90% Efficient, Custom PSU (Wide Ranging, Active PFC) | |
| Operating Voltage Range | 90–269 VAC | |
| Rated Voltage Range | 100-127 VAC 200-240 VAC | 118 VAC |
| Rated Line Frequency | 50-60 Hz | 400 Hz |
| Operating Line Frequency Range | 47-66 Hz | 393-407 Hz |
| Rated Input Current | 12 A @ 100-127 VAC 6.3 A @ 200-240 VAC | 12A @ 118 VAC |
| Heat Dissipation (Configuration and software dependent) | Typical = 2467 btu/hr Maximum = 4112 btu/hr | |
| Power Supply Fan | 80x25 mm variable speed | |
| ENERGY STAR® Qualified (Configuration dependent) | Yes | |
| 80 PLUS® Compliant | Yes, 90% Efficient The Z6 G4 1000W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP_D15-1K0P1A_1000W_ECOS%204838_Report.pdf | |
| FEMP Standby Power Compliant @115V (<1W in S5 – Power Off) | Yes | |
| EuP Compliant @ 230V (<0.5 W in S5 – Power Off) | Yes | |
| CECP Compliant @ 220V (<4W in S3 – Suspend to RAM) | Yes; Configuration dependent | |
| Power Consumption in sleep mode (as defined by ENERGY STAR®) – Suspend to RAM (S3) (Instantly Available PC) | <= 20W | |
| Built-in Self Test LED | Yes | |
| Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V) | Yes | |

| | |
|------------------------------------|--|
| Sensor Header | Integrated in Front User Interface (Power Switch, Power LED, HDD LED, Speaker) Cable |
| Integrated Gigabit Ethernet | Integrated Intel® I219LM GbE LAN |
| Clear CMOS Button | Yes |

System Technical Specifications

System Configuration

| | | | | | | | |
|---------------------------------------|-----------------|---|--|--|--|--|--|
| Example Z6 G4 Configuration #1 | Processor | 1x Intel Xeon 3104 (Six-core) | | | | | |
| | Memory | 1x 8GB DDR4-2666 (Registered DIMM) | | | | | |
| | Graphics | 1x NVIDIA Quadro P400 | | | | | |
| | Disks / Optical | 1x 500GB SATA 7200 ; 1x Slim DVD-ROM SATA | | | | | |
| | Power Supply | 1000W 90% custom PSU | | | | | |
| | Other | NA | | | | | |

| | | | | | | | |
|---------------------------|-----------------------|-------------|--------------|-------------|--------------|-------------|-------------|
| Energy Consumption | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled |
| | Windows Idle (S0) | 54.109 | | 54.586 | | 54.906 | |
| | Windows Busy Typ(S0) | 94.256 | | 94.275 | | 94.043 | |
| | Windows Busy Max (S0) | 95.992 | | 95.268 | | 95.643 | |
| | Sleep (S3) | 6.219 | 6.205 | 6.319 | 6.306 | 6.334 | 6.239 |
| | Off (S5) | 3.354 | 3.343 | 3.521 | 3.341 | 3.350 | 3.342 |
| | Zero Power Mode (ErP) | 0.209 | | 0.388 | | 0.195 | |

| | | | | | | | |
|----------------------------------|-----------------------|-------------|--------------|-------------|-------------|--------------|-------------|
| Heat Dissipation (Btu/hr) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled |
| | Windows Idle (S0) | 184.619 | | 186.247 | | 187.339 | |
| | Windows Busy Typ(S0) | 321.601 | | 321.666 | | 320.875 | |
| | Windows Busy Max (S0) | 327.524 | | 325.054 | | 326.334 | |
| | Sleep (S3) | 21.219 | 21.171 | 21.561 | 21.516 | 21.611 | 21.287 |
| | Off (S5) | 11.444 | 11.406 | 12.014 | 11.399 | 11.430 | 11.403 |
| | Zero Power Mode (ErP) | 0.713 | | 1.323 | | 0.665 | |

| | | | | | | | |
|---------------------------------------|-----------------|---------------------------------------|--|--|--|--|--|
| Example Z6 G4 Configuration #2 | Processor | 1x Intel Xeon 4108 (Eight-core) | | | | | |
| | Memory | 4x 8GB DDR4-2666 (Registered DIMM) | | | | | |
| | Graphics | 1x NVIDIA Quadro P2000 | | | | | |
| | Disks / Optical | 2x 1TB SATA 7200 ; 1x Slim DVDRW SATA | | | | | |
| | Power Supply | 1000W 90% custom PSU | | | | | |
| | Other | NA | | | | | |

| | | | | | | | |
|-----------------------------------|-----------------------|-------------|--------------|-------------|--------------|-------------|-------------|
| Energy Consumption (Watts) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled |
| | Windows Idle (S0) | 61.661 | | 61.531 | | 61.354 | |
| | Windows Busy Typ(S0) | 168.665 | | 167.375 | | 166.535 | |
| | Windows Busy Max (S0) | 166.097 | | 163.682 | | 169.674 | |
| | Sleep (S3) | 7.231 | 7.177 | 7.229 | 7.217 | 7.324 | 7.248 |
| | Off (S5) | 3.376 | 3.366 | 3.527 | 3.512 | 3.354 | 3.350 |
| | Zero Power Mode (ErP) | 0.211 | | 0.386 | | 0.195 | |

| | | | | | | | |
|----------------------------------|---------|-------------|--------------|-------------|-------------|--------------|-------------|
| Heat Dissipation (Btu/hr) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled |
| Windows Idle (S0) | 210.387 | | 209.944 | | 209.340 | | |

System Technical Specifications

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|-----------------------|---------|--------|---------|--------|---------|--------|
| Windows Busy Typ(S0) | 575.485 | | 571.084 | | 568.217 | |
| Windows Busy Max (S0) | 576.959 | | 575.543 | | 578.928 | |
| Sleep (S3) | 24.672 | 24.488 | 24.665 | 24.624 | 24.989 | 24.730 |
| Off (S5) | 11.519 | 11.484 | 12.034 | 11.983 | 11.443 | 11.430 |
| Zero Power Mode (ErP) | 0.720 | | 1.317 | | 0.665 | |

| | | | | | | |
|--|---------------|---------------------------------------|--|--|--|--|
| Example Z6 G4 Configuration #3 ENERGY STAR QUALIFIED | Processor | 1x Intel Xeon 6136 (Twelve-core) | | | | |
| | Memory | 6x 8GB DDR4-2666 (Registered DIMM) | | | | |
| | Graphics | 1x NVIDIA QuadroP4000 | | | | |
| | Disks/Optical | 2x 1TB SATA 7200 ; 1x Slim DVDRW SATA | | | | |
| | Power Supply | 1000W 90% custom PSU | | | | |
| | Other | NA | | | | |

| | | | | | | | |
|-----------------------------------|-----------------------|-------------|--------------|-------------|--------------|-------------|-------------|
| Energy Consumption (Watts) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled |
| | Windows Idle (S0) | 79.074 | | 79.109 | | 79.938 | |
| | Windows Busy Typ(S0) | 324.975 | | 317.991 | | 327.451 | |
| | Windows Busy Max (S0) | 328.268 | | 320.296 | | 329.668 | |
| | Sleep (S3) | 7.847 | 7.756 | 7.878 | 7.826 | 7.931 | 7.852 |
| | Off (S5) | 3.353 | 3.348 | 3.535 | 3.489 | 3.373 | 3.355 |
| | Zero Power Mode (ErP) | 0.206 | | 0.386 | | 0.196 | |

| | | | | | | | |
|----------------------------------|-----------------------|-------------|--------------|-------------|-------------|--------------|-------------|
| Heat Dissipation (Btu/hr) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled |
| | Windows Idle (S0) | 269.801 | | 269.920 | | 272.748 | |
| | Windows Busy Typ(S0) | 1108.815 | | 1084.985 | | 1117.262 | |
| | Windows Busy Max (S0) | 1120.051 | | 1092.850 | | 1124.827 | |
| | Sleep (S3) | 26.774 | 26.463 | 26.880 | 26.702 | 27.061 | 26.791 |
| | Off (S5) | 11.441 | 11.426 | 12.061 | 11.904 | 11.509 | 11.447 |
| | Zero Power Mode (ErP) | 0.703 | | 1.317 | | 0.669 | |

| | | | | | | |
|---------------------------------------|-----------------|---------------------------------------|--|--|--|--|
| Example Z6 G4 Configuration #4 | Processor | 2x Intel Xeon 8160 (Dual 24-core) | | | | |
| | Memory | 12x 32GB DDR4-2666 (Registered DIMM) | | | | |
| | Graphics | 2x NVIDIA Quadro P5000 | | | | |
| | Disks / Optical | 4x 2TB SATA 7200 ; 1x Slim DVDRW SATA | | | | |
| | Power Supply | 1000W 90% custom PSU | | | | |
| | Other | NA | | | | |

| | | | | | | | |
|-----------------------------------|-----------------------|-------------|--------------|-------------|--------------|-------------|-------------|
| Energy Consumption (Watts) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled |
| | Windows Idle (S0) | 112.388 | | 115.635 | | 112.102 | |
| | Windows Busy Typ(S0) | 512.368 | | 490.165 | | 526.905 | |
| | Windows Busy Max (S0) | 698.548 | | 673.465 | | 706.461 | |
| | Sleep (S3) | 14.208 | 13.833 | 14.698 | 14.487 | 15.176 | 13.886 |

System Technical Specifications

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|-------------------------------------|-----------------------|-------------|--------------|-------------|-------------|--------------|-------------|
| | Off (S5) | 3.511 | 3.418 | 3.575 | 3.570 | 3.509 | 3.412 |
| | Zero Power Mode (ErP) | 0.287 | | 0.387 | | 0.272 | |
| Heat Dissipation (Btu/hr) | | 115 VAC | | 230 VAC | | 100 VAC | |
| | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled |
| | Windows Idle (S0) | 383.469 | | 394.547 | | 382.492 | |
| | Windows Busy Typ(S0) | 1748.120 | | 1672.443 | | 1797.800 | |
| | Windows Busy Max (S0) | 2383.446 | | 2297.863 | | 2410.445 | |
| | Sleep (S3) | 48.478 | 47.198 | 50.150 | 49.430 | 51.781 | 47.379 |
| | Off (S5) | 11.980 | 11.662 | 12.198 | 12.181 | 11.973 | 11.642 |
| | Zero Power Mode (ErP) | 0.979 | | 1.321 | | 0.928 | |

NOTE: Power consumption measurements do not take advantage of the Intel Turbo Boost Technology. As a result, power consumption measurements may be higher.

DECLARED NOISE EMISSIONS

| | | | |
|--|-----------------------|---|--|
| System Configuration (Entry level) | Processor Info | Intel® Xeon® Gold 6130 processor 2.1GHz 12C CPU | |
| | Memory Info | 24GB (3x8GB) DDR4-2666 ECC Memory RDIMMs | |
| | Graphics Info | 1-NVIDIA® Quadro® P400 2GB | |
| | Disks/Optical | 1-500GB SATA 7200RPM 3.5" HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer | |
| | Power Supply | 1000 W | |

| | | | |
|---|---|------------------------------------|--|
| Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
| | Idle | 3.3 | 15 |
| | Hard drive Operating (random reads) | 3.5 | 18 |

| | | | |
|--|-----------------------|--|--|
| System Configuration (Mid-range) | Processor Info | Intel® Xeon® Platinum 8168 processor 2.7GHz 24C CPU | |
| | Memory Info | 96GB (6x16GB) DDR4-2666 ECC Memory RDIMMs | |
| | Graphics Info | 1-NVIDIA® Quadro® P6000 24GB | |
| | Disks/Optical | 2-4TB 6Gb/s 7200RPM SATA HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer | |
| | Power Supply | 1000 W | |

| | | | |
|---|---|------------------------------------|--|
| Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
| | Idle | 3.8 | 23 |
| | Hard drive Operating (random reads) | 3.9 | 23 |

System Technical Specifications

| | | |
|--|-----------------------|--|
| System Configuration (High end) | Processor Info | 2-Intel® Xeon® Gold 6136 processor 3.0GHz 12C CPU |
| | Memory Info | 192GB (12x16GB) DDR4-2666 ECC Memory RDIMMs |
| | Graphics Info | 1-NVIDIA® Quadro® P6000 24GB |
| | Disks/Optical | 2-4TB 6Gb/s 7200RPM SATA HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer |
| | Power Supply | 1000 W |

| Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
|---|-------------|------------------------------------|--|
| | Idle | | 3.8 |
| Hard drive Operating (random reads) | | 3.9 | 24 |

ENVIRONMENTAL DATA

| | | |
|-----------------------------------|-------------------------------|--|
| Environmental Requirements | Temperature | Operating: 5° to 35° C (40° to 95° F) Non-operating: -40° to 60° C (-40° to 140° F) |
| | Humidity | Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb |
| | Maximum Altitude | Operating: 3,048 m (10,000 feet) Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation Non-operating: 9,144 m (30,000 feet) |
| | Shock (non-repetitive) | Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) square: 422 cm/s, 20g |
| | Vibration | Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g ² /Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g ² /Hz |

Physical Security and Serviceability

| | |
|--|--|
| Access Panel | Tool-less Includes system board and memory information. |
| Optical Drive | Tool-less, no carrier or rails required |
| Hard Drives | Tool-less Optional 5.25" external bay carriers |
| Expansion Cards | Tool-less |
| Processor Socket | 1st socket on main system board. 2nd socket on optional 2nd CPU/Memory Module. |
| Blue User Touch Points | Yes, on primary serviceable components. |
| Color-coordinated Cables and Connectors | Yes |

System Technical Specifications

| | |
|--|---|
| Memory | Tool-less |
| System Board | Torx T15 screws 2nd CPU/Memory Module: Tool-less |
| Front of Computer LEDs | Dual Color Power/Failure LED = Yes HDD Activity LED = Yes |
| Configuration Record SW | Yes |
| Over-Temp Warning on Screen | Yes, at POST screen on reboot |
| Restore CD/DVD Set | Yes, restores the computer to its original factory shipping image; can be obtained via HP Support. |
| Dual Function Front Power Switch | Yes, also acts as a reset switch when held for 4 seconds. |
| Padlock Support | Yes |
| Cable Lock Support | Kensington Cable Lock (optional): Prevents entire system theft and system access. 3mm x 7mm slot at rear of system |
| Universal Chassis Clamp Lock Support | No |
| Solenoid Lock and Hood Sensor | Access Panel Solenoid Lock: Yes (optional). Activated remotely to prevent system entry. Access Panel Intrusion Sensor: Yes (optional). |
| Removable Media Write/Boot Control | Yes, user can prevent the workstation from writing to or booting from removable media. |
| Power-On Password Setup Password | Yes, prevents an unauthorized person from booting up the workstation |
| 3.3V Aux Power LED on System PCA | Yes, prevents an unauthorized person from changing the workstation configuration |
| NIC LEDs (integrated) (Green & Amber) | Yes |
| CPUs and Heatsinks | CPU heatsink removal requires a T-30 Torx screwdriver. |
| Power Supply Diagnostic LED | Yes |
| Front Power Button | Yes |
| Rear Power Button | Yes |
| Front Power LED | Yes, white (normal), red (fault) |
| Front Hard Drive Activity LED | Yes, white |
| Front ODD Activity LED | Yes on device |
| Internal Speaker | Yes |
| System/Emergency ROM Flash Recovery | Recovers corrupted system BIOS. |
| Cooling Solutions | Air cooled forced convection |
| Power Supply Fans | 1 - 80 mm x 80 mm x 25 mm (non-serviceable) |
| CPU Heatsink Fan | 1st CPU: 1 - 80mm Optional 2nd CPU: 1 - 60mm x 25mm |
| Memory Fan | Front memory fan: 1 - 80mm x 25mm Memory duct blower: 1 - 90mm x 25mm 2nd CPU/Memory Module: 1 - 60mm x 25mm |

System Technical Specifications

| | |
|---|--|
| Chassis Fans | Front chassis fan : 1 - 120mm x 25mm Rear chassis fan: 1 - 120mm x 25mm |
| HP Vision Diagnostics Offline Edition | HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing ESC then F2 upon the PC reboot, and is available as a download from HP Support. |
| Access Panel Key Lock | Yes, side panel barrel keylock (optional from the factory only) |
| ACPI-Ready Hardware | Advanced Configuration and Power Management Interface (ACPI). <ul style="list-style-type: none"> • Allows the system to wake from a low-power mode. • Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system |
| Trusted Platform Module Chip | Integrated Infineon TPM 2.0. TCG and FIPS 140-2 Certified |
| Integrated Chassis Handles | Yes, Front handle and dedicated rear recess |
| Power Supply | Requires T15 Torx or flat blade screwdriver |
| PCIe Card Retention | Yes, tool-less Rear (all) Middle (full-height cards) Front (full-length cards with extender) |
| Flash ROM | Yes |
| Diagnostic Power Switch LED on board | Yes |
| Clear Password Jumper | Yes |
| Clear CMOS Button | Yes |
| CMOS Battery Holder | Yes |
| DIMM Connectors | Yes |
| BIOS | |
| BIOS 32-bit Services | Standard BIOS 32-bit Service Directory Proposal v0.4 |
| PCI 3.0 Support | Full BIOS support for PCI Express through industry standard interfaces. |
| ATAPI | ATAPI Removable Media Device BIOS Specification Version 1.0. |
| BBS | BIOS Boot Specification v1.01. |
| WMI Support | WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications. |
| BIOS Boot Spec 1.01+ | Provides more control over how and from what devices the workstation will boot. |
| BIOS Power On | Users can define a specific date and time for the system to power on. |
| ROM Based Computer Setup Utility (F10) | Review and customize system configuration settings controlled by the BIOS. |
| System/Emergency ROM Flash Recovery with Video | Recovers system BIOS in corrupted Flash ROM. |
| Replicated Setup | Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup). |
| SMBIOS | System Management BIOS 2.8, for system management information. |
| Boot Control | Disables the ability to boot from removable media on supported devices. |
| Memory Change Alert | Alerts management console if memory is removed or changed. |

System Technical Specifications

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|---|--|
| Thermal Alert | Monitors the temperature state within the chassis. Three modes: <ul style="list-style-type: none"> • NORMAL - normal temperature ranges. • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. • SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs. |
| Remote ROM Flash | Provides secure, fail-safe ROM image management from a central network console. |
| ACPI (Advanced Configuration and Power Management Interface) | Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 5.0 for full compatibility with 64-bit operating systems. |
| Ownership Tag | A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen. |
| Remote Wakeup/Remote Shutdown | System administrators can power on, restart, and power off a client computer from a remote location. |
| Instantly Available PC (Suspend to RAM - ACPI sleep state S3) | Allows for very low power consumption with quick resume time. |
| Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server) | Allows a new or existing system to boot over the network and download software, including the operating system. |
| ROM revision levels | Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW applications can use and report this information. |
| System board revision level | Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified. |
| Start-up Diagnostics (Power-on Self-Test) | Assesses system health at boot time with selectable levels of testing. |
| Auto Setup when new hardware installed | System automatically detects addition of new hardware. |
| Keyboard-less Operation | The system can be booted without a keyboard. |
| Localized ROM Setup | Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with local keyboard mappings. |
| Asset Tag | The user or MIS to set a unique tag string in non-volatile memory. |
| Per-slot Control | Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. |
| Adaptive Cooling | Control parameters are set according to detected hardware configuration for optimal acoustics. |
| Pre-boot Diagnostics | (Pre-video) critical errors are reported via beeps and blinks on the power LED. |
| Industry Standard Specification Support | |
| Industry Standard UEFI Specification Revision | Revision Supported by the BIOS 2.6 |
| ACPI | Advanced Configuration and Power Management Interface, Version 5.0 |
| ATA (IDE) | AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b |
| CD Boot | "El Torito" Bootable CD-ROM Format Specification Version 1.0 |
| EDD | - Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0 |
| EHCI | Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 |
| PCI | PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7 |

System Technical Specifications

| | |
|--------------------|---|
| PCI Express | PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0 |
| PMM | POST Memory Manager Specification, Version 1.01 |
| SATA | Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 |
| SPD | PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B |
| TPM | Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670) Common Criteria EAL4+ Certified FIPS 140-2 Certification TCG TPM Certified products list: http://www.trustedcomputinggroup.org/certification/tpm-certified-products/ |
| UHCI | Universal Host Controller Interface Design Guide, Revision 1.1 |
| USB | Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification |
| SMBIOS | System Management BIOS Reference Specification, Version 2.8 |

External BIOS simulator found at: <http://csrsmc.itcs.hp.com/>

Social and Environmental Responsibility

Eco-Label Certifications & Declarations This product is low halogen except for HP Z Turbo Quad Pro PCIe TLC SSD, CRU QX 428 & QX448 removable storage frames, ConnectX-6 DX Amphenol 10 & 25 Gb Transceivers, power cords, cables, and peripherals. Service parts obtained after purchase may not be Low Halogen.

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- ENERGY STAR® (energy-saving features available on selected configurations-Windows only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program
- The ECO declaration (TED)
- TCO Certified configurations available*

*TCO Certified configurations available when ENERGY STAR configurations are selected with a USB Type-C® connector. ENERGY STAR available with a combination of high-performance CPU's, high-performance GPU's and select memory configurations.

The Z6 G4 is registered EPEAT® Silver in the US and Canada. EPEAT® registration varies by country. See <http://www.epeat.net> for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at <http://www.hp.com/go/options>

Batteries

The battery in this product complies with EU Directive 2006/66/EC
Battery mass: 3g
Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40ppm by weight

System Technical Specifications

Restricted Material Usage This product meets the material restrictions specified in HP's General Specification for the Environment.

HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis

Low Halogen Statement This product is low halogen except for power cords, external cables and peripherals. Service parts obtained after purchase may not be low halogen.

(NOTE: optional low-halogen power cables are available for some countries in Europe)

End-of-Life Management and Recycling HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.

HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:
[Sustainability Report](#)

Eco-label certifications:

<http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html>

ISO 14001 certificate:

<http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html>

Additional Information

- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. [Product Disassembly Instructions](#)
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.

Packaging

HP Workstation product packaging meets the [HP's General Specification for the Environment](#)

- Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment
- Does not contain ozone-depleting substances (ODS)
- Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed
- Maximizes the use of post-consumer recycled content materials in packaging materials
- All packaging material is recyclable
- All packaging material is designed for ease of disassembly
- Reduced size and weight of packages to improve transportation fuel efficiency
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting
- A multi-unit eco packaging option is available to institutional customers that uses less packaging material or has a lower volume footprint than conventional single-unit packaging. Please contact your sales representative for additional details.

Packaging Materials

Internal

Cushions and plastic bags made of low density polyethylene (LDPE).

External

Outer carton, accessories carton, and insert made of corrugated paper board.

Manageability

Industry Standard Specifications

This product meets the following industry standard specifications for manageability functionality:

- DASH 1.1 (via Intel® LAN on motherboard)

System Technical Specifications

Intel® Active Management Technology (AMT)

An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 11.2x includes the following advanced management functions:

- Power Management (on, off, reset, graceful shutdown, sleep and hibernate)
 - Support in Max Power Savings (Shutdown and Hibernate Modes)
- Hardware Inventory (includes BIOS and firmware revisions)
- Hardware Alerting
- Agent Presence
- System Defense Filters
- Serial Over LAN (SOL)
- USB Redirect (Media Redirection)
- ME Wake-on-LAN (WOL), even with Maximum Power Savings Enabled
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance.
- Remote Alerts - automatically alert IT or service provider if issues arise
- Access Monitor - Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Local Time Sync to UTC
- Remote Memory Dump Command - Creates memory dump for debug

Intel® vPro™ Technology

The HP Z6 G4 Workstation supports Intel® vPro™ technology when configured as outlined below:

- Intel® Xeon® processor Scalable Family
- Intel® C622 chipset
- Intel® I219LM GbE LAN

Remote Manageability Software Solutions

The HP Z6 G4 Workstation is supported on the following remote manageability software consoles:

- LANDesk Management Suite (HP recommended solution)
- Microsoft System Center Configuration Manager
- HP Client Automation Enterprise

For questions or support for manageability needs, please visit

<http://www.hp.com/go/clientmanagement>

For questions or support for SSM, please visit: <http://www.hp.com/go/ssm>

System Software Manager

Service, Support, and Warranty

On-site Warranty and Service (**Note 1**): Three-years, limited warranty and service offering delivers on-site, next business-day (**Note 2**) service for parts and labor and includes free telephone support (**Note 3**) 8am - 5pm. Global coverage (**Note 2**) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are

System Technical Specifications

based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/lookuptool>. Additional HP Care Pack Services information by product is available at: <http://www.hp.com/hps/carepack>. Service levels and response times for HP Care Packs may vary depending on your geographic location.

Certification and Compliance

Environmental Sustainability questions concerning:

Ecolabels (EPEAT, TCO, etc.)

ENERGY STAR, California Energy Commission (CEC)

Compliance with Environmental legislation (EU ErP, China CECP, EU RoHS and other countries)

Supply Chain Social Environmental Responsibility (SER) (conflict minerals; human rights, etc.)

Product specific environmental features (material content, packaging content, recycled content, etc.)

China Energy Label (CEL)

Please contact sustainability@hp.com

For country specific Regulatory Compliance approval documents or Regulatory and Safety questions concerning:

Declarations of Conformity (for self-service, go to https://www.hp.com/uk-en/certifications/technical/regulations-certificates.html?jumpid=ex_r135_uk/en/any/corp/hpuk-mu_chev/certificates)

GS Certificates

Product Safety Certificates (UL, CB, BIS, etc.)

EMC Certificates, Declarations of Conformity, or Certificates of Conformity (CE, FCC, ICES, etc.)

CCC Certificates

Ergonomics

Please contact techregshelp@hp.com

Product Change Notification

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

Stable & Consistent Offerings

Global Series SKUs

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

Stable & Consistent Offerings

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors

| Product # | Offering |
|------------------|--|
| 2DL32AV | Intel® Xeon® Gold 6128 processor |
| 2DL33AV, 1XM44AA | Intel® Xeon® Gold 6128 2 nd processor |
| 2DL22AV | Intel® Xeon® Silver 4114 processor |
| 2DL23AV, 1XM49AA | Intel® Xeon® Silver 4114 2nd processor |
| 2DL18AV | Intel® Xeon® Silver 4108 processor |
| 2DL19AV, 1XM51AA | Intel® Xeon® Silver 4108 2 nd processor |

Hard Drives

| Product # | Offering |
|------------------|----------------------------|
| Z5H22AV, LQ037AA | 1TB SATA 7200 RPM 3.5" HDD |
| Z5H23AV | 1TB 7200RPM SATA 3.5in 2nd |
| Z5H25AV | 1TB 7200RPM SATA 3.5in 3rd |
| Z5H24AV | 1TB 7200RPM SATA 3.5in 4th |

Graphics

| Product # | Offering |
|-----------|----------|
| N/A | N/A |

Memory

| Product # | Offering |
|-----------|----------|
| N/A | N/A |

Optical and Removable Storage

| Product # | Offering |
|-----------|----------|
| N/A | N/A |

Technical Specifications - Processors

Intel® Xeon® W-3200 Series CPU

Intel® Xeon® W-3265 2.7 2933 24C processor

Intel® Xeon® W-3245 3.2 2933 16C processor

Intel® Xeon® W-3225 3.7 2666 8C processor

Intel® Xeon® W-3223 3.5 2666 8C processor

Intel® Xeon® Scalable CPU

Intel® Xeon® Gold 6258R processor

Intel® Xeon® Gold 6248R processor

Intel® Xeon® Gold 6246R processor

Intel® Xeon® Gold 6244 processor

Intel® Xeon® Gold 6242R processor

Intel® Xeon® Gold 6242 processor

Intel® Xeon® Gold 6240 processor

Intel® Xeon® Gold 6234 processor

Intel® Xeon® Gold 6230R processor

Intel® Xeon® Gold 6226R processor

Intel® Xeon® Gold 6226 processor

Intel® Xeon® Gold 6136 processor

Intel® Xeon® Gold 6128 processor

Intel® Xeon® Gold 5222 processor

Intel® Xeon® Gold 5220R processor

Intel® Xeon® Gold 5218R processor

Intel® Xeon® Gold 5218 processor

Intel® Xeon® Gold 5118 processor

Intel® Xeon® Silver 4216 processor

Intel® Xeon® Silver 4215R processor

Intel® Xeon® Silver 4214R processor

Intel® Xeon® Silver 4214 processor

Intel® Xeon® Silver 4210R processor

Intel® Xeon® Silver 4210 processor

Intel® Xeon® Silver 4208 processor

Intel® Xeon® Silver 4114 processor

Intel® Xeon® Silver 4108 processor

Intel® Xeon® Bronze 3206R processor

Intel® Xeon® Bronze 3204 processor

Technical Specifications - Hard Drives

STORAGE/HARD DRIVES

| | | | | |
|--|---------------------------------|--|--------------------------------------|----------------|
| HP SAS (Serial Attached SCSI) Hard Drives for HP Workstations | HP 300GB SAS 15K SFF HDD | Capacity | 300GB | |
| | | Height | 5.9 in; 15 cm | |
| | | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | Interface | 12Gb/s SAS | |
| | | Synchronous Transfer Rate (Maximum) | Up to 1200 MB/s (SAS single port)* | |
| | | Buffer | 128MB | |
| | | Seek Time (typical reads, includes controller overhead, including settling) | Average | 2.0ms * |
| | | Rotational Speed | 15K rpm | |
| | | Operating Temperature | 41° to 131° F (5° to 55° C) | |
| | | | <i>*Actual performance may vary.</i> | |

Technical Specifications - Hard Drives

SATA (Serial ATA) Hard Drives for HP Workstations

**500GB SATA 7200 rpm
6Gb/s 3.5" HDD**

| | |
|--|--------------------------------------|
| Capacity | 500GB |
| Height | 1 in; 2.54 cm |
| Width | Media Diameter 3.5 in; 8.9 cm |
| | Physical Size 4 in; 10.17 cm |
| Interface | Serial ATA (6.0Gb/s), NCQ enabled |
| Synchronous Transfer Rate (Maximum) | Up to 600MB/s* |
| Buffer | 16MB |
| Seek Time (typical reads, includes controller overhead, including settling) | Single Track 2 ms* |
| | Average 11 ms* |
| | Full Stroke 21 ms* |
| Rotational Speed | 7,200 rpm |
| Logical Blocks | 976,773,168 |
| Operating Temperature | 41° to 131° F (5° to 55° C) |

*Actual performance may vary.

**1TB SATA 7200 rpm
6Gb/s 3.5" HDD**

| | |
|--|--------------------------------------|
| Capacity | 1TB |
| Height | 1 in; 2.54 cm |
| Width | Media Diameter 3.5 in; 8.9 cm |
| | Physical Size 4 in; 10.17 cm |
| Interface | Serial ATA (6.0Gb/s), NCQ enabled |
| Synchronous Transfer Rate (Maximum) | Up to 600 MB/s* |
| Buffer | 64MB |
| Cache | Adaptive |
| Seek Time (typical reads, includes controller overhead, including settling) | Single Track 2 ms* |
| | Average 11 ms* |
| | Full Stroke 21 ms* |
| Rotational Speed | 7,200 rpm |
| Operating Temperature | 41° to 131° F (5° to 55° C) |

*Actual performance may vary.

**2.0TB SATA 7200 rpm
6Gb/s 3.5" HDD CMR**

| | |
|--|--------------------------------------|
| Capacity | 2.0TB |
| Height | 1 in; 2.54 cm |
| Width | Media Diameter 3.5 in; 8.9 cm |
| | Physical Size 4 in; 10.17 cm |
| Interface | Serial ATA (6.0 Gb/s), NCQ Enabled |
| Synchronous Transfer Rate (Maximum) | Up to 600 MB/s* |
| Buffer | 64MB |
| Seek Time (typical reads, includes controller overhead, including settling) | Single Track 1.0 ms* |
| | Average 11 ms* |
| | Full Stroke 18 ms* |
| Rotational Speed | 7,200 rpm |

Technical Specifications - Hard Drives

| | | | |
|---|--|------------------------------------|------------------|
| | Logical Blocks | 3,907,029,168 | |
| | Operating Temperature | 41° to 131° F (5° to 55° C) | |
| | <i>*Actual performance may vary.</i> | | |
| 2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD SMR | Capacity | 2.0TB | |
| | Height | 1 in; 2.54 cm | |
| | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | Physical Size | 4 in; 10.17 cm |
| | Interface | Serial ATA (6.0 Gb/s), NCQ Enabled | |
| | Synchronous Transfer Rate (Maximum) | Up to 600 MB/s* | |
| | Buffer | 64MB | |
| | Seek Time (typical reads, includes controller overhead, including settling) | Single Track | 1.2 ms* |
| | | Average | 12 ms* |
| | | Full Stroke | 21 ms* |
| | Rotational Speed | 7,200 rpm | |
| | Logical Blocks | 3,907,029,168 | |
| | Operating Temperature | 41° to 140° F (5° to 60° C) | |
| | <i>*Actual performance may vary.</i> | | |
| 3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD | Capacity | 3.0TB | |
| | Height | 1 in; 2.54 cm | |
| | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | Physical Size | 4.0 in; 10.17 cm |
| | Interface | Serial ATA (6.0Gb/s), NCQ enabled | |
| | Synchronous Transfer Rate (Maximum) | Up to 6.0 Gb/s* | |
| | Buffer | 64MB | |
| | Seek Time (typical reads, includes controller overhead, including settling) | Single Track | 0.6 ms* |
| | | Average | 11 ms* |
| | | Full Stroke | Not Specified* |
| | Rotational Speed | 7,200 rpm | |
| | Operating Temperature | 41° to 140° F (5° to 60° C) | |
| | <i>*Actual performance may vary.</i> | | |

Technical Specifications - Hard Drives

**1TB SATA 7200 rpm
6Gb/s 3.5" HDD
(Enterprise Class)**

| | | |
|--|---------------------------------|----------------|
| Capacity | 1TB | |
| Protocol | SATA | |
| Form Factor | 3.5" | |
| Controller | AHCI | |
| Reliability (MTBF) | 2.0M hours | |
| Rated Power On Hours | 8760/yr | |
| Annualized Failure Rate (based on Rated POH) | <0.62% | |
| Rated for 24/7/365 operation | YES | |
| Physical Size (Height) | 1 in; 2.54 cm | |
| Physical Size (Width) | 4 in; 10.17 cm | |
| Media Diameter | 3.5 in; 8.9 cm | |
| Interface | Serial ATA (6Gb/s), NCQ enabled | |
| Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| Buffer | 128MB | |
| Seek Time (typical reads, includes controller overhead, including settling) | Single Track | 0.32ms* |
| | Average | 7.45ms* |
| | Full Stroke | 14.2ms* |
| Operating Temperature | 41° to 140° F (5° to 60° C) | |
| Performance | Sequential Read | up to 226MB/s* |
| | Sequential Write | up to 226MB/s* |
| Enterprise Class Features | High Reliability | |

*Actual performance may vary.

Technical Specifications - Hard Drives

4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)

| | |
|--|---------------------------------------|
| Capacity | 4TB |
| Height | 0.275 in; 0.7 cm |
| Width | Media Diameter 2.5 in; 6.36 cm |
| | Physical Size 2.75 in; 6.99 cm |
| Interface | Serial ATA (6Gb/s), NCQ enabled |
| Synchronous Transfer Rate (Maximum) | Up to 600MB/s* |
| Buffer | 128MB |
| Seek Time (typical reads, includes controller overhead, including settling) | Single Track 0.7ms* |
| | Average 8.5ms* |
| | Full Stroke 15.7ms* |
| Rotational Speed | 7,200 rpm |
| Operating Temperature | 32° to 140° F (0° to 60° C) |

*Actual performance may vary.

500GB SATA 7.2K SED SFF HDD

| | |
|--|---------------------------------------|
| Capacity | 500GB |
| Height | 0.275 in; 0.7 cm |
| Width | Media Diameter 2.5 in; 6.36 cm |
| | Physical Size 2.75 in; 6.99 cm |
| Interface | Serial ATA (6Gb/s) |
| Synchronous Transfer Rate (Maximum) | Up to 600MB/s* |
| Buffer | 32MB |
| Seek Time (typical reads, includes controller overhead, including settling) | Single Track 1ms* |
| | Average 4.2ms* |
| | Full Stroke 25ms (typical)* |
| Rotational Speed | 7,200 rpm |
| Operating Temperature | 32° to 140° F (0° to 60° C) |

*Actual performance may vary.

Technical Specifications - Hard Drives

SATA SSDs for HP Workstations

HP 256GB SATA 6Gb/s SSD

| | |
|--|--|
| Capacity | 256GB |
| Protocol | SATA |
| Form Factor | 2.5" |
| Controller | AHCI |
| NAND Type | 3D TLC |
| Endurance | 192TBW (TB Written) |
| Reliability (MTTF) | 1.5M hours |
| Physical Size (Height) | 0.28 in; 0.7 cm |
| Physical Size (Width) | 2.5 in; 6.36 cm |
| Interface | SATA 6Gb/s |
| Synchronous Transfer Rate (Maximum) | Up to 600MB/s* |
| Operating Temperature | 32° to 158° F (0° to 70° C) |
| Performance | |
| | Sequential Read 530MB/s (max)* |
| | Sequential Write 500MB/s (max)* |
| | Random Read 95K IOPS (max)* |
| | Random Write 83K IOPS (max)* |

*Actual performance may vary.

HP 256GB SATA 6Gb/s SED Opal 2 SSD

| | |
|--|-----------------------------------|
| Capacity | 256GB |
| Protocol | SATA |
| Form Factor | 2.5" |
| Controller | AHCI |
| NAND Type | 3D TLC |
| Endurance | 192TBW (TB Written) |
| Reliability (MTTF) | 1.5M hours |
| Physical Size (Height) | 0.28 in; 0.7 cm |
| Physical Size (Width) | 2.5 in; 6.36 cm |
| Interface | 6Gb/s SATA |
| Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequential Read)* |
| Operating Temperature | 32° to 158° F (0° to 70° C) |
| Performance | |
| | Sequential Read 530MB/s* |
| | Sequential Write 500 MB/s* |
| | Random Read 95K IOPS* |
| | Random Write 83K IOPS* |
| Self-Encrypting Drive Support | OPAL 2 |

*Actual performance may vary.

HP 512GB SATA 6Gb/s SSD

| | |
|--------------------|---------------------|
| Capacity | 512GB |
| Protocol | SATA |
| Form Factor | 2.5" |
| Controller | AHCI |
| NAND Type | 3D TLC |
| Endurance | 388TBW (TB Written) |

Technical Specifications - Hard Drives

| | | |
|--|----------------------------------|-----------|
| Reliability (MTTF) | 1.5M hours | |
| Physical Size (Height) | 0.28 in; 0.7 cm | |
| Physical Size (Width) | 2.5 in; 6.36 cm | |
| Interface | SATA 6Gb/s | |
| Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequential Read)* | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | |
| Performance | Sequential Read | 530 MB/s* |
| | Sequential Write | 500 MB/s* |
| | Random Read | 95K IOPS* |
| | Random Write | 83K IOPS* |

*Actual performance may vary.

| | | | |
|--------------------------------------|--|-----------------------------|-----------|
| HP 512GB SATA SED SSD | Capacity | 512GB | |
| | Protocol | SATA | |
| | Form Factor | 2.5" | |
| | Controller | AHCI | |
| | NAND Type | 3D TLC | |
| | Endurance | 388TBW (TB Written) | |
| | Reliability (MTTF) | 1.5M hours | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | SATA 6Gb/s | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 530 MB/s* |
| | | Sequential Write | 500 MB/s* |
| Random Read | | 95K IOPS* | |
| Random Write | | 83K IOPS* | |
| Self-Encrypting Drive Support | OPAL 1 and 2 | | |

*Actual performance may vary.

| | | |
|------------------------------|--|----------------------------------|
| HP 1TB SATA 6Gb/s SSD | Capacity | 1TB |
| | Protocol | SATA |
| | Form Factor | 2.5" |
| | Controller | AHCI |
| | NAND Type | 3D TLC |
| | Endurance | 400TBW (TB Written) |
| | Reliability (MTTF) | 1.5M hours |
| | Physical Size (Height) | 0.28 in; 0.7 cm |
| | Physical Size (Width) | 2.5 in; 6.36 cm |
| | Interface | SATA 6Gb/s |
| | Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequential Read)* |
| | Operating Temperature | 32° to 158° F (0° to 70° C) |

Technical Specifications - Hard Drives

| | | |
|--------------------|-------------------------|-----------|
| Performance | Sequential Read | 530 MB/s* |
| | Sequential Write | 500 MB/s* |
| | Random Read | 95K IOPS* |
| | Random Write | 83K IOPS* |

*Actual performance may vary.

HP 2TB SATA 6Gb/s SSD

| | |
|--|------------------------------------|
| Capacity | 2TB |
| Protocol | SATA |
| Form Factor | 2.5" |
| Controller | AHCI |
| NAND Type | 3D TLC |
| Endurance | 400TBW (TB Written) |
| Reliability (MTTF) | 1.5M hours |
| Physical Size (Height) | 0.28 in; 0.7 cm |
| Physical Size (Width) | 2.5 in; 6.36 cm |
| Interface | SATA 6Gb/s |
| Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequential Read)* |
| Operating Temperature | 32° to 158° F (0° to 70° C) |
| Performance | Sequential Read 530 MB/s* |
| | Sequential Write 500 MB/s * |
| | Random Read 95K IOPS* |
| | Random Write 83K IOPS* |

*Actual performance may vary.

HP Enterprise Class 240GB SATA SSD

| | |
|--|--|
| Capacity | 240GB |
| Protocol | SATA |
| Form Factor | 2.5" |
| Controller | AHCI |
| NAND Type | 3D TLC |
| Endurance | 2,200TBW (TB Written) |
| Reliability (MTTF) | 2.0M hours |
| Physical Size (Height) | 0.28 in; 0.7 cm |
| Physical Size (Width) | 2.5 in; 6.36 cm |
| Interface | 6Gb/s SATA |
| Synchronous Transfer Rate (Maximum) | Up to 600MB/s* |
| Operating Temperature | 32° to 158° F (0° to 70° C) |
| Performance | Sequential Read 540 MB/s* |
| | Sequential Write 310 MB/s* |
| | Random Read 93K IOPS* |
| | Random Write 48K IOPS* |
| Enterprise Class Features | High Endurance NAND Power Loss Protection End-to-End Data Protection |

*Actual performance may vary.

Technical Specifications - Hard Drives

HP Enterprise Class 480GB SATA SSD

| | | |
|--|--|-----------|
| Capacity | 480GB | |
| Protocol | SATA | |
| Form Factor | 2.5" | |
| Controller | AHCI | |
| NAND Type | 3D TLC | |
| Endurance | 4,400TBW (TB Written) | |
| Reliability (MTTF) | 2.0M hours | |
| Physical Size (Height) | 0.28 in; 0.7 cm | |
| Physical Size (Width) | 2.5 in; 6.36 cm | |
| Interface | 6Gb/s SATA | |
| Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | |
| Performance | Sequential Read | 540 MB/s* |
| | Sequential Write | 460 MB/s* |
| | Random Read | 93K IOPS* |
| | Random Write | 74K IOPS* |
| Enterprise Class Features | High Endurance NAND Power Loss Protection End-to-End Data Protection | |

*Actual performance may vary.

Performance PCIe SSDs for HP Workstations

HP Z Turbo Drive 256GB M.2 2280 TLC SSD

| | | |
|------------------------------|---|-------------|
| Capacity | 256GB | |
| Protocol | PCIe | |
| Form Factor | M.2 | |
| Controller | NVMe | |
| NAND Type | 3D TLC | |
| SED Support | Opal 2 | |
| Endurance | 200TB | |
| Reliability (MTBF) | 1.5M hours | |
| Interface | PCI Express 3.0 x4 electrical x4 physical | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | |
| Performance | Sequential Read | 3500 MB/s * |
| | Sequential Write | 2200 MB/s * |
| | Random Read | 240K IOPS * |
| | Random Write | 480K IOPS * |

*Actual performance may vary.

HP Z Turbo Drive 512GB M.2 2280 TLC SSD

| | |
|--------------------|--------|
| Capacity | 512GB |
| Protocol | PCIe |
| Form Factor | M.2 |
| Controller | NVMe |
| NAND Type | 3D TLC |
| SED Support | Opal 2 |
| Endurance | 300TB |

Technical Specifications - Hard Drives

| | | |
|------------------------------|---|-------------|
| Reliability (MTBF) | 1.5M hours | |
| Interface | PCI Express 3.0 x4 electrical x4 physical | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | |
| Performance | Sequential Read | 3500 MB/s* |
| | Sequential Write | 2900 MB/s* |
| | Random Read | 460 K IOPS* |
| | Random Write | 500K IOPS* |

*Actual performance may vary.

HP ZTurbo Drive 1TB M.2 2280 TLC SSD

| | | |
|------------------------------|---|------------|
| Capacity | 1TB | |
| Protocol | PCIe | |
| Form Factor | M.2 | |
| Controller | NVMe | |
| NAND Type | 3D TLC | |
| SED Support | Opal 2 | |
| Endurance | 400TB | |
| Reliability (MTBF) | 1.5M hours | |
| Interface | PCI Express 3.0 x4 electrical x4 physical | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | |
| Performance | Sequential Read | 3500 MB/s* |
| | Sequential Write | 3000 MB/s* |
| | Random Read | 580K IOPS* |
| | Random Write | 500K IOPS* |

*Actual performance may vary.

HP ZTurbo Drive 2TB M.2 2280 TLC SSD

| | | |
|------------------------------|---|------------|
| Capacity | 2TB | |
| Protocol | PCIe | |
| Form Factor | M.2 | |
| Controller | NVMe | |
| NAND Type | 3D TLC | |
| SED Support | Opal 2 | |
| Endurance | 500TB | |
| Reliability (MTTF) | 1.5M hours | |
| Interface | PCI Express 3.0 x4 electrical x4 physical | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | |
| Performance | Sequential Read | 3300 MB/s* |
| | Sequential Write | 2400 MB/s* |
| | Random Read | 500K IOPS* |
| | Random Write | 440K IOPS* |

*Actual performance may vary.

HP Z Turbo Drive Quad Pro 2x256GB PCIe TLC SSD

| | | |
|--------------------|----------------------------------|--|
| Capacity | 512GB | |
| Protocol | PCIe | |
| Form Factor | PCIe Card, Full Height PCIe Slot | |

Technical Specifications - Hard Drives

| | | |
|------------------------------|-----------------------------|------------|
| Controller | NVMe | |
| NAND Type | 3D TLC | |
| SED Support | Opal 2 | |
| Endurance | 200TB | |
| Reliability (MTBF) | 1.5M hours | |
| Interface | PCIe Gen3 x4 architecture | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | |
| Performance | Sequential Read | 3500 MB/s* |
| | Sequential Write | 2200 MB/s* |
| | Random Read | 240K IOPS* |
| | Random Write | 480K IOPS* |

*Actual performance may vary.

| | | | | |
|---|------------------------------|----------------------------------|-------------|--|
| HP Z Turbo Drive Quad Pro 2x512GB PCIe TLC SSD | Capacity | 1TB | | |
| | Protocol | PCIe | | |
| | Form Factor | PCIe Card, Full Height PCIe Slot | | |
| | Controller | NVMe | | |
| | NAND Type | 3D TLC | | |
| | SED Support | Opal 2 | | |
| | Endurance | 300TB | | |
| | Reliability (MTBF) | 1.5M hours | | |
| | Interface | PCIe Gen3 x4 architecture | | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | | |
| | Performance | Sequential Read | 3500 MB/s* | |
| | | Sequential Write | 2900 MB/s* | |
| | | Random Read | 460 K IOPS* | |
| Random Write | | 500K IOPS* | | |

*Actual performance may vary.

| | | | | |
|---|------------------------------|---|------------|--|
| HP Z Turbo Drive Quad Pro 2x1TB PCIe TLC SSD | Capacity | 2TB | | |
| | Protocol | PCIe | | |
| | Form Factor | PCIe Card, Full Height PCIe Slot | | |
| | Controller | NVMe | | |
| | NAND Type | 3D TLC | | |
| | SED Support | Opal 2 | | |
| | Endurance | 400TB | | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | | |
| | Performance | Sequential Read | 3500 MB/s* | |
| | | Sequential Write | 3000 MB/s* | |
| | | Random Read | 580K IOPS* | |
| | | Random Write | 500K IOPS* | |

*Actual performance may vary.

Technical Specifications - Hard Drives

HP Z Turbo Drive Dual Pro 256GB SSD

| | | | | | | | | | |
|------------------------------|--|------------------------|------------|-------------------------|------------|--------------------|------------|---------------------|------------|
| Capacity | 256GB | | | | | | | | |
| Protocol | PCIe | | | | | | | | |
| Form Factor | M.2 in Half-height, half-length card | | | | | | | | |
| Controller | NVMe | | | | | | | | |
| NAND Type | 3D TLC | | | | | | | | |
| Endurance | 200TBW (TB Written) | | | | | | | | |
| Reliability (MTBF) | 1.5M hours | | | | | | | | |
| Interface | PCI Express 3.0 x4 electrical x4 physical | | | | | | | | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | | | | | | | | |
| Performance | <table> <tr> <td>Sequential Read</td> <td>3500 MB/s*</td> </tr> <tr> <td>Sequential Write</td> <td>2200 MB/s*</td> </tr> <tr> <td>Random Read</td> <td>240K IOPS*</td> </tr> <tr> <td>Random Write</td> <td>480K IOPS*</td> </tr> </table> | Sequential Read | 3500 MB/s* | Sequential Write | 2200 MB/s* | Random Read | 240K IOPS* | Random Write | 480K IOPS* |
| Sequential Read | 3500 MB/s* | | | | | | | | |
| Sequential Write | 2200 MB/s* | | | | | | | | |
| Random Read | 240K IOPS* | | | | | | | | |
| Random Write | 480K IOPS* | | | | | | | | |

*Actual performance may vary.

HP Z Turbo Drive Dual Pro 512GB SSD

| | | | | | | | | | |
|------------------------------|---|------------------------|------------|-------------------------|------------|--------------------|-------------|---------------------|------------|
| Capacity | 512GB | | | | | | | | |
| Protocol | PCIe | | | | | | | | |
| Form Factor | M.2 in Half-height, half-length card | | | | | | | | |
| Controller | NVMe | | | | | | | | |
| NAND Type | 3D TLC | | | | | | | | |
| Endurance | 300TBW (TB Written) | | | | | | | | |
| Reliability (MTBF) | 1.5M hours | | | | | | | | |
| Interface | PCI Express 3.0 x4 electrical x4 physical | | | | | | | | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | | | | | | | | |
| Performance | <table> <tr> <td>Sequential Read</td> <td>3500 MB/s*</td> </tr> <tr> <td>Sequential Write</td> <td>2900 MB/s*</td> </tr> <tr> <td>Random Read</td> <td>460 K IOPS*</td> </tr> <tr> <td>Random Write</td> <td>500K IOPS*</td> </tr> </table> | Sequential Read | 3500 MB/s* | Sequential Write | 2900 MB/s* | Random Read | 460 K IOPS* | Random Write | 500K IOPS* |
| Sequential Read | 3500 MB/s* | | | | | | | | |
| Sequential Write | 2900 MB/s* | | | | | | | | |
| Random Read | 460 K IOPS* | | | | | | | | |
| Random Write | 500K IOPS* | | | | | | | | |

*Actual performance may vary.

HP Z Turbo Drive Dual Pro 1TB SSD

| | | | | | | | | | |
|------------------------------|--|------------------------|------------|-------------------------|------------|--------------------|------------|---------------------|------------|
| Capacity | 1TB | | | | | | | | |
| Protocol | PCIe | | | | | | | | |
| Form Factor | M.2 in Half-height, half-length card | | | | | | | | |
| Controller | NVMe | | | | | | | | |
| NAND Type | 3D TLC | | | | | | | | |
| Endurance | 400TBW (TB Written) | | | | | | | | |
| Reliability (MTBF) | 1.5M hours | | | | | | | | |
| Interface | PCI Express 3.0 x4 electrical x4 physical | | | | | | | | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | | | | | | | | |
| Performance | <table> <tr> <td>Sequential Read</td> <td>3500 MB/s*</td> </tr> <tr> <td>Sequential Write</td> <td>3000 MB/s*</td> </tr> <tr> <td>Random Read</td> <td>580K IOPS*</td> </tr> <tr> <td>Random Write</td> <td>500K IOPS*</td> </tr> </table> | Sequential Read | 3500 MB/s* | Sequential Write | 3000 MB/s* | Random Read | 580K IOPS* | Random Write | 500K IOPS* |
| Sequential Read | 3500 MB/s* | | | | | | | | |
| Sequential Write | 3000 MB/s* | | | | | | | | |
| Random Read | 580K IOPS* | | | | | | | | |
| Random Write | 500K IOPS* | | | | | | | | |

*Actual performance may vary.

Technical Specifications - Hard Drives

HP Z Turbo Drive Dual Pro 2TB SSD

| | | | | | | | | | |
|------------------------------|---|------------------------|------------|-------------------------|-------------|--------------------|------------|---------------------|------------|
| Capacity | 2TB | | | | | | | | |
| Protocol | PCIe | | | | | | | | |
| Form Factor | M.2 in Half-height, half-length card | | | | | | | | |
| Controller | NVMe | | | | | | | | |
| NAND Type | 3D TLC | | | | | | | | |
| Endurance | 500TBW (TB Written) | | | | | | | | |
| Reliability (MTBF) | 1.5M hours | | | | | | | | |
| Interface | PCI Express 3.0 x4 electrical x4 physical | | | | | | | | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | | | | | | | | |
| Performance | <table> <tr> <td>Sequential Read</td> <td>3500 MB/s*</td> </tr> <tr> <td>Sequential Write</td> <td>3000 MB/s *</td> </tr> <tr> <td>Random Read</td> <td>600K IOPS*</td> </tr> <tr> <td>Random Write</td> <td>500K IOPS*</td> </tr> </table> | Sequential Read | 3500 MB/s* | Sequential Write | 3000 MB/s * | Random Read | 600K IOPS* | Random Write | 500K IOPS* |
| Sequential Read | 3500 MB/s* | | | | | | | | |
| Sequential Write | 3000 MB/s * | | | | | | | | |
| Random Read | 600K IOPS* | | | | | | | | |
| Random Write | 500K IOPS* | | | | | | | | |

*Actual performance may vary.

Mainstream PCIe SSDs for HP Workstations

HP 256GB M.2 2280 TLC SSD

| | | | | | | | | | |
|------------------------------|--|------------------------|-------------|-------------------------|-------------|--------------------|--------------|---------------------|--------------|
| Capacity | 256GB | | | | | | | | |
| Protocol | PCIe | | | | | | | | |
| Form Factor | M.2 | | | | | | | | |
| Controller | NVMe | | | | | | | | |
| NAND Type | 3D TLC | | | | | | | | |
| Endurance | 200TB | | | | | | | | |
| Reliability (MTBF) | 1.5M hours | | | | | | | | |
| Interface | PCI Express 3.0 x4 electrical x4 physical | | | | | | | | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | | | | | | | | |
| Performance | <table> <tr> <td>Sequential Read</td> <td>3100 MB/s *</td> </tr> <tr> <td>Sequential Write</td> <td>1400 MB/s *</td> </tr> <tr> <td>Random Read</td> <td>200 K IOPS *</td> </tr> <tr> <td>Random Write</td> <td>320 K IOPS *</td> </tr> </table> | Sequential Read | 3100 MB/s * | Sequential Write | 1400 MB/s * | Random Read | 200 K IOPS * | Random Write | 320 K IOPS * |
| Sequential Read | 3100 MB/s * | | | | | | | | |
| Sequential Write | 1400 MB/s * | | | | | | | | |
| Random Read | 200 K IOPS * | | | | | | | | |
| Random Write | 320 K IOPS * | | | | | | | | |

*Actual performance may vary.

HP 512GB M.2 2280 TLC SSD

| | | | | | | | | | |
|------------------------------|--|------------------------|------------|-------------------------|------------|--------------------|-------------|---------------------|-------------|
| Capacity | 512GB | | | | | | | | |
| Protocol | PCIe | | | | | | | | |
| Form Factor | M.2 | | | | | | | | |
| Controller | NVMe | | | | | | | | |
| NAND Type | 3D TLC | | | | | | | | |
| Endurance | 300TB | | | | | | | | |
| Reliability (MTBF) | 1.5M hours | | | | | | | | |
| Interface | PCI Express 3.0 x4 electrical x4 physical | | | | | | | | |
| Operating Temperature | 32° to 158° F (0° to 70° C) | | | | | | | | |
| Performance | <table> <tr> <td>Sequential Read</td> <td>3300 MB/s*</td> </tr> <tr> <td>Sequential Write</td> <td>2500 MB/s*</td> </tr> <tr> <td>Random Read</td> <td>225 K IOPS*</td> </tr> <tr> <td>Random Write</td> <td>430 K IOPS*</td> </tr> </table> | Sequential Read | 3300 MB/s* | Sequential Write | 2500 MB/s* | Random Read | 225 K IOPS* | Random Write | 430 K IOPS* |
| Sequential Read | 3300 MB/s* | | | | | | | | |
| Sequential Write | 2500 MB/s* | | | | | | | | |
| Random Read | 225 K IOPS* | | | | | | | | |
| Random Write | 430 K IOPS* | | | | | | | | |

*Actual performance may vary.

Technical Specifications - Hard Drives

| | | | |
|--------------------------------|------------------------------|---|-------------|
| HP 1TB M.2 2280 TLC SSD | Capacity | 1TB | |
| | Protocol | PCIe | |
| | Form Factor | M.2 | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 400TB | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 3300 MB/s* |
| | | Sequential Write | 2500 MB/s* |
| | | Random Read | 400 K IOPS* |
| | | Random Write | 440 K IOPS* |

*Actual performance may vary.

| | | | |
|--------------------------------|------------------------------|---|-------------|
| HP 2TB M.2 2280 TLC SSD | Capacity | 2TB | |
| | Protocol | PCIe | |
| | Form Factor | M.2 | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 500TB | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | Operating Temperature | 32° to 158° F (0° to 70° C) | |
| | Performance | Sequential Read | 3300 MB/s* |
| | | Sequential Write | 2700 MB/s* |
| | | Random Read | 430 K IOPS* |
| | | Random Write | 500 K IOPS* |

*Actual performance may vary.

**Intel® 905p Series AIC
PCIe SSD**

**Intel® 905p Series AIC
280GB PCIe SSD**

| | | | |
|--|------------------------------|-----------------------------|------------|
| | Capacity | 280GB | |
| | Protocol | PCIe | |
| | Form Factor | PCIe Card, Half Height | |
| | Controller | NVMe | |
| | NVM Type | 3DXPoint | |
| | Endurance | 5.11 PBW (PB Written) | |
| | Reliability (MTBF) | 1.6M hours | |
| | Operating Temperature | 32° to 185° F (0° to 85° C) | |
| | Performance | Sequential Read | 2730 MB/s* |
| | | Sequential Write | 2280 MB/s* |
| | | Random Read | 587K IOPS* |
| | | Random Write | 559K IOPS* |

*Actual performance may vary.

| | |
|-----------------|-------|
| Capacity | 480GB |
|-----------------|-------|

Technical Specifications - Hard Drives

| | | | |
|--|------------------------------|-----------------------------|------------|
| Intel® 905p Series AIC 480GB PCIe SSD | Protocol | PCIe | |
| | Form Factor | PCIe Card, Half Height | |
| | Controller | NVMe | |
| | NVM Type | 3DXPoint | |
| | Endurance | 8.76 PBW (PB Written) | |
| | Reliability (MTBF) | 1.6M hours | |
| | Operating Temperature | 32° to 185° F (0° to 85° C) | |
| | Performance | Sequential Read | 2710 MB/s* |
| | | Sequential Write | 2280 MB/s* |
| | | Random Read | 582K IOPS* |
| | | Random Write | 561K IOPS* |

*Actual performance may vary.

| | | | | |
|--|---|------------------------------|--|------------|
| Intel® Optane™ DC Persistent Memory | Intel® Optane™ DC Persistent Memory 128GB Module | Capacity | 128GB | |
| | | Protocol | DDR-T | |
| | | Form Factor | DDR4 | |
| | | Controller | NVMe | |
| | | NVM Type | 3DXPoint | |
| | | Endurance | 292 PBW (256B Sequential Write) 91 PBW (64B Sequential Write) | |
| | | Reliability (MTBF) | 2M hours | |
| | | Operating Temperature | 32° to 185° F (0° to 85° C) | |
| | | Performance | Sequential Read | 6800 MB/s* |
| | | | Sequential Write | 1850 MB/s* |

*Actual performance may vary.

Technical Specifications - Hard Drive Controllers

HARD DRIVE CONTROLLERS

| | | | |
|---|---------------------------------------|---|--------------------|
| Microsemi SmartHBA2100-4i4e SAS Card | PCI Bus | 8 lanes, PCI Express 3.0 | |
| | RAID Levels | Offers Integrated RAID (0, 1, and 10) | |
| | PCI Data Burst Transfer Rate | Half Duplex x8, PCIe, 8000 MB/s | |
| | SAS Bandwidth | Half Duplex | 1200 MB/s per lane |
| | PCI Card Type | 3.3V Add-in Card | |
| | PCI Voltage | 12 V ± 10% | |
| | PCI Power | 9.8W typical, Airflow min 200 LFM | |
| | Bracket | Full height and low profile | |
| | Certification Level | PCI Express 3.0 compliant | |
| | SAS Processor | Microsemi SmartIO 2100 SAS IO Controller | |
| | Internal Connectors | One x4 internal mini-SASHD (SFF-8643) | |
| | External Connectors | One x4 external mini-SASHD (SFF-8644) | |
| | Maximum Number of SCSI Devices | 256 Non-RAID SAS/SATA devices | |
| | LED Indicators | Connector for Drive Activity Light NOTE: RAID 5 is not supported on MicroSemi 2100-4i4e 8-port SAS 12Gb/s RAID Card | |

Technical Specifications - Graphics

GRAPHICS

**NVIDIA® Quadro® P620
2GB Graphics**

Form Factor

Dimensions: 2.713” H x 5.7” L
Single Slot, Low Profile
Cooling: Active
Weight: 129 grams

Graphics Controller

NVIDIA® Quadro® P620 Graphics Card
GPU: 512 CUDA cores
Max Power: 40 Watts

Bus Type

PCI Express 3.0 x16

Memory

Size: 2 GB GDDR5, 2000 MHz
Memory Interface: 128-bit
Memory Bandwidth: 64 GB/s

Connectors

4mDP Outputs *

Maximum Resolution

DisplayPort™ 1.4:
- up to 4x 5120 x 2880 x 24 bpp @ 60Hz
- supports Multi-Stream Transport (MST)

Image Quality Features

10-bit internal display processing pipeline
10-bit scan-out support

Display Output

4 mDP Connectors

Shading Architecture

Full Microsoft DirectX 12 Shader Model 5.1

Supported Graphics APIs

OpenGL 4.5
DirectX 12
Vulkan 1.0
API support includes:
CUDA C, CUDA C++, DirectCompute , OpenCL

Available Graphics Drivers

Windows 11
Windows10
Windows 7 Professional

Linux®

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

Notes

*P620 only have mini-DisplayPort™ (mDP) video ports.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included

After market option kit:Two mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories:

- 2MY05AA - HP miniDP-to-DP Adapter Cables
- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Technical Specifications - Graphics

NVIDIA® T400 4GB Graphics

| | |
|-----------------------------------|---|
| Form Factor | Dimensions: 2.713" H x 6.137" L Single Slot, Low Profile Weight: 124g |
| Graphics Controller | NVIDIA® T400 Graphics Card GPU: 384 CUDA cores Power: 30 Watts Cooling: Active |
| Bus Type | PCI Express 3.0 x16 |
| Memory | Size: 4 GB GDDR6 Memory Interface: 64-bit Memory Bandwidth: 80 GB/s |
| Connectors | 3x mDP |
| Maximum Resolution | 3x 5120 x 2880 x 24 bpp @ 60Hz |
| Supported Graphics APIs | OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA, OpenCL 1.x |
| Available Graphics Drivers | Windows 11 Windows 10 Linux |

HP qualified drivers may be preloaded or available from the HP support Web site:
<http://welcome.hp.com/country/us/en/support.html>

NVIDIA® Quadro® P1000 4GB Graphics

| | |
|--------------------------------|--|
| Form Factor | Dimensions: 2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams |
| Graphics Controller | NVIDIA® Quadro® P1000 Graphics Card GPU: 640 NVIDIA® CUDA® cores Max Power: 47 Watts |
| Bus Type | PCI Express 3.0 x16 |
| Memory | Size: 4 GB GDDR5, 2500 MHz Memory Interface: 128-bit memory interface Memory Bandwidth: 80 GB/s memory bandwidth |
| Connectors | 4mDP Outputs |
| Maximum Resolution | DisplayPort™ 1.4: - up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST) |
| Image Quality Features | 10-bit internal display processing pipeline 10-bit scan-out support |
| Display Output | 4 mDP Connectors |
| Shading Architecture | Full Microsoft DirectX® 12 Shader Model 5.1 |
| Supported Graphics APIs | OpenGL® 4.5 DirectX® 12 Vulkan™ 1.0 |

Technical Specifications - Graphics

| | |
|-----------------------------------|--|
| Available Graphics Drivers | <p>API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL™</p> <p>Windows 11 Windows 10 Windows 7 Professional Linux®</p> <p>HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html</p> |
|-----------------------------------|--|

Notes

| | |
|---|--|
| AMD Radeon™ Pro WX 3200 4GB Graphics | <p>Form Factor Low-Profile Single Slot (2.75 "H x 6.6" L)</p> <p>Graphics Controller Radeon™ Pro WX 3200 Graphics Card GPU: 640 Stream Processors organized into 8 Compute Units Power: 56 Watts Cooling: Active</p> <p>Memory 4GB GDDR5 memory Memory Bandwidth: 96 GB/s Memory Width: 128 bit</p> <p>Connectors 4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.</p> <p>Factory Configured: No adapters included After market option kit: One mDP-to-DP cable adapters included</p> <p>Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.</p> |
| Maximum Resolution | <p>5K support @ 60Hz</p> <ul style="list-style-type: none"> 1x single-cable 5K monitor, or 2x dual-cable 5K monitors <p>4x 4K support @ 60Hz</p> |
| Image Quality Features | Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling |
| Display Output | 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support |
| GPU Architecture | Polaris |
| Supported Graphics APIs | DirectX®12 OpenGL® 4.6 OpenCL™ 2.0 Vulkan™ 1.0 |
| Available Graphics Drivers | <p>Windows 11 Windows 10 Linux® 64-bit (selected Enterprise distributions)</p> <p>HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html</p> |

Technical Specifications - Graphics

Notes

1. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
2. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
3. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

NVIDIA® T1000 4GB Graphics

Form Factor

Dimensions: 2.713" H x 6.137" L
Single Slot
Weight: 132.6 grams

Graphics Controller

NVIDIA® T1000 Graphics Card
Power: 50W
Cooling: Active

Bus Type

PCI Express 3.0 x16

Memory

Size: 4GB GDDR6
Memory Bandwidth: Up to 160 GB/s
Memory Width: 128-bit

Connectors

4x mini DisplayPort™ 1.4a

Maximum Resolution

7680 x 4320 @ 120Hz

Display Output

Maximum number of displays: 4 displays

Architecture

NVIDIA® Turing™

Supported Graphics APIs

xx

Available Graphics Drivers

Windows 11
Windows 10
Windows 8.1
Windows 7 Professional
Linux® - Full OpenGL® implementation, complete with NVIDIA® Quadro® and ARB extensions

HP qualified drivers may be preloaded or available from the HP support Web site:
<http://welcome.hp.com/country/us/en/support.html>

NVIDIA® T1000 8GB Graphics

Form Factor

Dimensions: 2.713" H x 6.137" L
Single Slot
Weight: 132.6 grams

Graphics Controller

NVIDIA® T1000 Graphics Card
Power: 50W
Cooling: Active

Technical Specifications - Graphics

| | |
|-----------------------------------|---|
| Bus Type | PCI Express 3.0 x16 |
| Memory | Size: 8GB GDDR6 Memory Bandwidth: Up to 160 GB/s Memory Width: 128-bit |
| Connectors | 4x mini DisplayPort™ 1.4a |
| Maximum Resolution | 7680 x 4320 @ 120Hz |
| Display Output | Maximum number of displays: 4 displays |
| Architecture | NVIDIA® Turing™ |
| Available Graphics Drivers | Windows 11 Windows 10 Windows 8.1 Windows 7 Professional Linux® - Full OpenGL® implementation, complete with NVIDIA® Quadro® and ARB extensions |
| | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |

| | | |
|---------------------------------------|-----------------------------------|--|
| NVIDIA® RTX A2000 6GB Graphics | Form Factor | Dimensions: 2.713" H x 6.6" L Dual slot, half-height Weight: 295 grams (without extender) |
| | Graphics Controller | NVIDIA® RTX A2000 Graphics Card Power: 70W Cooling: Active |
| | Bus Type | PCI Express 4.0 x16 |
| | Memory | Size: 6GB GDDR6 Memory Bandwidth: Up to 288 GB/s Memory Width: 192-bit |
| | Connectors | 4x mini-DisplayPort™ 1.4a |
| | Maximum Resolution | Up to 4x 5120 x 2880 x 24bpp @ 60Hz |
| | Architecture | NVIDIA® Ampere™ |
| | Supported Graphics APIs | CUDA, OpenCL™ 1.x |
| | Available Graphics Drivers | Windows 11 Windows 10 Linux® 64-bit (selected Enterprise distributions) HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | <ol style="list-style-type: none"> RTX A2000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately as AMO: <ol style="list-style-type: none"> 2MY05AA - HP Single miniDP-to-DP Adapter Cable 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables Two mDP-to-DP adapters are included with the RTX A2000 when it is ordered as an AMO kit. |

Technical Specifications - Graphics

| | | |
|--|------------------------------------|--|
| NVIDIA® RTX A4000 16GB Graphics | Form Factor | Full-Height Single Slot (4.4" Height x 9.5" Length) |
| | Graphics Controller | NVIDIA® RTX A4000 Graphics GPU: 6144 NVIDIA® CUDA® Parallel Processing Cores Power: 140 Watts Cooling: Active |
| | Memory | 16GB GDDR6 memory Memory Bandwidth: Up to 448 GB/s Memory Width: 256 bit |
| | Connectors | 4x DP One 6-pin auxiliary power connector Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | 7680x4320 @ 60Hz |
| | Display Outputs¹ | 4x DP |
| | Supported Graphics APIs | DirectX® 12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows 11 Windows 10 Linux® 64-bit HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |

| | | |
|--|----------------------------|--|
| NVIDIA® RTX A4500 20GB Graphics | Form Factor | Full-Height Dual Slot (4.4" Height x 10.5" Length) |
| | Graphics Controller | NVIDIA® RTX A4500 Graphics GPU: 7168 NVIDIA® CUDA® Parallel Processing Cores Power: 200 Watts Cooling: Active |
| | Memory | 20GB GDDR6 memory Memory Bandwidth: Up to 640 GB/s Memory Width: 320 bit |

Technical Specifications - Graphics

| | |
|------------------------------------|---|
| Connectors | <p>4x DP One 8-pin auxiliary power connector</p> <p>Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.</p> <p>DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.</p> |
| Maximum Resolution | 7680x4320 @ 60Hz |
| Display Outputs¹ | 4x DP |
| Supported Graphics APIs | <p>DirectX® 12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0</p> <p>Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran</p> |
| Available Graphics Drivers | <p>Windows 11 Windows 10 Linux® 64-bit</p> <p>HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html</p> |

NVIDIA® RTX A5000 24GB Graphics

| | |
|----------------------------|---|
| Form Factor | <p>Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1049 grams + 80 grams extender</p> |
| Graphics Controller | <p>NVIDIA® RTX A5000 GPU: 8192 CUDA Cores Power: 230W Cooling: Active</p> |
| Memory | <p>24GB GDDR6 Memory Bandwidth: Up to 768GB/s ECC Memory (disabled by default)</p> |
| Connectors | <p>DP (x4) with HDR support One 8-pin auxiliary power connector</p> <p>After market option Kit: no power adapter included with card.</p> <p>DisplayPort™ to VGA, DisplayPort™ to DVI (single-link and dual-link), and DisplayPort™ to HDMI adapters available as accessories.</p> |

Technical Specifications - Graphics

| | |
|-----------------------------------|---|
| Maximum Resolution | DisplayPort™ 1.4a: 7680x4320 @ 120Hz |
| Display Outputs | 4x DP1.4a HDR2 outputs (up to 7680x4320 @ 120Hz) |
| GPU Architecture | NVIDIA® Ampere™ |
| Supported Graphics APIs | DirectX®12, OpenGL® 4.5 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| Available Graphics Drivers | Windows 11 Windows 10 Windows 7 HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html Factory Configured (Z4/Z6/Z8 G4 Workstation): No adapters included After market option kit: No adapters included |

NVIDIA® RTX™ A6000 48GB Graphics

| | |
|--------------------------------|---|
| Form Factor | Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1230 grams / 2.71 lbs (with extender) |
| Graphics Controller | NVIDIA® RTX™ A6000 Graphics GPU: 10752 NVIDIA® CUDA® Parallel Processing Cores Power: 300 Watts Cooling: Active |
| Memory | 48GB GDDR6 memory ECC optional Memory Bandwidth: Up to 768 GB/s Memory Width: 384 bit |
| Connectors | 4x DP 1.4a Quadro Sync II connector Ampere NVLink® Stereo Sync Requires 8-pin CPU auxiliary power |
| Maximum Resolution | 5120x2880 @ 60Hz (up to 4 displays) |
| Display Outputs | 4x DP 1.4 (7680x4320 @ 60Hz) |
| Supported Graphics APIs | DirectX®12, OpenGL® 4.6, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran™ |

Technical Specifications - Graphics

Available Graphics Drivers

Windows 11
Windows 10
Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support Web site:
<http://welcome.hp.com/country/us/en/support.html>

AMD Radeon™ Pro W5500 8GB

Form Factor

Full-Height Single Slot

Graphics Controller

Architecture: RDNA
GPU: 1408 Stream Processors organized into 22 Compute Units
Power: 125W
Cooling: Active

Memory

8GB GDDR6 memory
Memory Bandwidth: up to 224 GB/s
Memory Interface: 128-bit

Display Output

Max Displays: 4
Video Outputs: 4x DisplayPort™ 1.4

Factory Configured: No video cable adapter included
After market option kit: No video cable adapter included

Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.

Maximum Resolution

7690 x 4320 resolution @ 60Hz

Software API Support

DirectX®: 12
OpenGL® : 4.6,
OpenCL™ : 2.0
Vulkan™ 1.1

Available Graphics Drivers

HP qualified drivers may be preloaded or available from the HP support Web site:
<http://welcome.hp.com/country/us/en/support.html>

Form Factor

Full-Height Double Slot

Technical Specifications - Graphics

| | | |
|----------------------------------|-----------------------------------|--|
| AMD Radeon™ Pro W5700 8GB | Graphics Controller | Architecture: RDNA GPU: 2304 Stream Processors organized into 36 Compute Units Power: 205W Cooling: Active |
| | Memory | 8GB GDDR6 memory Memory Bandwidth: up to 448 GB/s Memory Interface: 256-bit |
| | Display Output | Max Displays: 6 Video Outputs: 5x Mini-DisplayPort™ 1.4 and 1x USB-C Factory Configured: No video cable adapter included After market option kit: No video cable adapter included Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
| | Maximum Resolution | 7690 x 4320 resolution @ 60Hz |
| | Software API Support | DirectX®: 12 OpenGL® : 4.6, OpenCL™ : 2.0 Vulkan™ 1.1 |
| | Available Graphics Drivers | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |

| | | |
|---|---|--|
| AMD Radeon™ Pro W6600 8GB Graphics | Form Factor | Full height, Single Slot, 241mm length |
| | Graphics Controller | AMD Radeon™ PR W6600 XT Graphics GPU: AMD RDNA 2 Memory: 8GB GDDR6 Power: 130 Watts, 6-pin Power Cable Cooling: Active, Dual Axial fan |
| | Bus Type | PCI Express 4.0 x16 |
| | Connectors | 4x DisplayPort 1.4 with DSC |
| | Maximum Resolution | DisplayPort™ 1.4 with DSC: - up to 4x @ 3840x2160px (4K) - up to 4x @ 5120x2880px (5K) - up to 1x @ 7680x4320px (8K) |
| | Display Outputs | 4x DP |
| | Shading Architecture | Microsoft DirectX 12 Shader Model 6.1 |
| Supported Graphics APIs | OpenGL 4.6 DirectX 12 Feature Level 12_1 | |

Technical Specifications - Graphics

Vulkan 1.1
OpenCL 2.2

Available Graphics Drivers

Windows 11
Windows 10
Linux® 64-bit (selected distributions)

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

AMD Radeon™ Pro W6800 32GB

Form Factor

Full-Height Double Slot

Graphics Controller

Architecture: RDNA 2
GPU Cores: 3840
Power: 261W
Cooling: Active fan heatsink

Memory

32GB GDDR6 memory
ECC Capable: Yes
Memory Bandwidth: up to 512 GB/s
Memory Interface: 256-bit

Display Output

Max Displays: 6
Video Output: 6x Mini-DisplayPort™ 1.4 with DSC
Display Configurations:
5K Resolution: 6x @ 5120 x 2880 resolution @ 60Hz
8K Resolution: 2x @ 7680 x 4320 resolution @60Hz

HDR Support: Yes

8K Support: Yes

Notes: W6800 only has mini-DisplayPort™ (mDP) video ports

- Configure-to-order must specify AV options to add any required mDP-to-DP Adapters
- Two mDP-to-DP Adapters are included in the RTX A2000 AMO kits
- If more mDP-to-DP Adapters are needed, Adapters can be ordered separately as AMO:
 - 2MY05AA - HP Single miniDP-to-DP Adapter Cable
 - 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Bus Type

PCI Express x16 Gen4

Software API Support

DirectX®: 12
OpenGL® : 4.6,
OpenCL™ : 2.1
Vulkan: 1.2

Technical Specifications - Graphics

Available Graphics Drivers

Windows 11
Windows 10

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

AMD Radeon™ Pro W5500 8GB

Form Factor

Full-Height Single Slot

Graphics Controller

Architecture: RDNA
GPU: 1408 Stream Processors organized into 22 Compute Units
Power: 125W
Cooling: Active

Memory

8GB GDDR6 memory
Memory Bandwidth: up to 224 GB/s
Memory Interface: 128-bit

Display Output

Max Displays: 4
Video Outputs: 4x DisplayPort™ 1.4

Factory Configured: No video cable adapter included
After market option kit: No video cable adapter included

Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.

Maximum Resolution

7690 x 4320 resolution @ 60Hz

Software API Support

DirectX®: 12
OpenGL®: 4.6,
OpenCL™: 2.0
Vulkan™ 1.1

Available Graphics Drivers

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

AMD Radeon™ Pro W5700 8GB

Form Factor

Full-Height Double Slot

Graphics Controller

Architecture: RDNA
GPU: 2304 Stream Processors organized into 36 Compute Units
Power: 205W
Cooling: Active

Technical Specifications - Graphics

| | |
|-----------------------------------|--|
| Memory | 8GB GDDR6 memory Memory Bandwidth: up to 448 GB/s Memory Interface: 256-bit |
| Display Output | Max Displays: 6 Video Outputs: 5x Mini-DisplayPort™ 1.4 and 1x USB-C Factory Configured: No video cable adapter included After market option kit: No video cable adapter included Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
| Maximum Resolution | 7690 x 4320 resolution @ 60Hz |
| Software API Support | DirectX®: 12 OpenGL® : 4.6, OpenCL™ : 2.0 Vulkan™ 1.1 |
| Available Graphics Drivers | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |

AMD Radeon™ Pro W6800 32GB

| | |
|----------------------------|---|
| Form Factor | Full-Height Double Slot |
| Graphics Controller | Architecture: RDNA 2 GPU Cores: 3840 Power: 261W Cooling: Active fan heatsink |
| Memory | 32GB GDDR6 memory ECC Capable: Yes Memory Bandwidth: up to 512 GB/s Memory Interface: 256-bit |
| Display Output | Max Displays: 6 Video Output: 6x Mini-DisplayPort™ 1.4 with DSC Display Configurations: 5K Resolution: 6x @ 5120 x 2880 resolution @ 60Hz 8K Resolution: 2x @ 7680 x 4320 resolution @60Hz HDR Support: Yes 8K Support: Yes |

Technical Specifications - Graphics

Notes: W6800 only has mini-DisplayPort™ (mDP) video ports

- Configure-to-order must specify AV options to add any required mDP-to-DP Adapters
- Two mDP-to-DP Adapters are included in the RTX A2000 AMO kits
- If more mDP-to-DP Adapters are needed, Adapters can be ordered separately as AMO:
 - 2MY05AA - HP Single miniDP-to-DP Adapter Cable
 - 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Bus Type

PCI Express x16 Gen4

Software API Support

DirectX®: 12
OpenGL® : 4.6,
OpenCL™ : 2.1
Vulkan: 1.2

Available Graphics Drivers

Windows 11
Windows 10

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

Technical Specifications – Optical and Removable Storage

OPTICAL AND REMOVABLE STORAGE

| | | | |
|---------------------------------|--|--|--|
| HP 9.5mm Slim DVD Writer | Description | 9.5mm height, tray-load | |
| | Mounting Orientation | Either horizontal or vertical | |
| | Interface Type | SATA/ATAPI | |
| | Dimensions (WxHxD) | 128 x 9.5 x 127mm | |
| | Supported Media Types | DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW | |
| | Disc Capacity | DVD-ROM Full Stroke DVD Full Stroke CD | 8.5 GB DL or 4.7 GB standard < 200 ms (seek) < 200 ms (seek) |
| | Maximum Data Transfer Rates | CD ROM Read DVD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X |
| | Power | Source DC Power Requirements DC Current | SATA DC power receptacle 5 VDC ± 5%-100 mV ripple p-p 5 VDC -< 800 mA typical, <1600 mA maximum |
| | Operating Environmental (all conditions non-condensing) | Temperature Relative Humidity Maximum Wet Bulb Temperature | 41° to 122° F (5° to 50° C) 10% to 80% 84° F (29° C) |
| | Operating Systems Supported | Windows 11, Windows 10, Windows 7 Professional 64-bit, Red Hat® Enterprise Linux®(RHEL) WS4**, 5, 6 Desktop/Workstation SUSE Linux® Enterprise Desktop 10 & 11 | |
| Kit Contents | HP SATA DVD Writer drive, installation guide. | | |

* No driver is required for this device. Native support is provided by the operating system.

| | | |
|------------------------------------|-----------------------------|-------------------------------|
| HP 9.5mm Slim DVD-ROM Drive | Description | 9.5mm height, tray-load |
| | Mounting Orientation | Either horizontal or vertical |
| | Interface Type | SATA / ATAPI |

Technical Specifications – Optical and Removable Storage

| | | |
|--|---|--|
| Dimensions (WxHxD) | 128 x 9.5 x 127mm | |
| Disc Capacity | DVD-ROM | Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB |
| Access Times | DVD-ROM Single Layer | < 110 ms (typical) |
| | CD-ROM Mode 1 | < 110 ms (typical) |
| | Full Stroke DVD | < 230 ms (typical) |
| | Full Stroke CD | < 220 ms (typical) |
| Power | Source | SATA DC power receptacle |
| | DC Power Requirements | 5 VDC ± 5%-100 mV ripple p-p |
| | DC Current | 5 VDC – <800mA typical, < 1600 mA maximum |
| Operating Environmental (all conditions non-condensing) | Temperature | 41° to 122° F (5° to 50° C) |
| | Relative Humidity | 10% to 80% |
| | Maximum Wet Bulb Temperature | 84° F (29° C) |
| Operating Systems Supported | Windows 11, Windows 10, Windows 7 Professional 64-bit Red Hat® Enterprise Linux®(RHEL) WS4**, 5, 6 Desktop/Workstation SUSE Linux® Enterprise Desktop 10 & 11 | |
| | No driver is required for this device. Native support is provided by the operating system. | |
| Kit Contents | 9.5mm Slim DVD-ROM Drive, 5.25" ODD Bay adapter/carrier, slim SATA data/power cable, installation guide | |

HP HH DVD Writer (16X RW DVD-R)

| | | |
|------------------------------------|---|---|
| Description | HP Half Height DVD Writer | |
| Mounting Orientation | Either Horizontal or vertical | |
| Interface Type | SATA | |
| Dimensions (WxHxD) | 146x42x165mm | |
| Supported Media Types | DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW | |
| Disc Capacity | DVD-ROM | 8.5 GB DL or 4.7 GB standard |
| | Full Stroke DVD | 145ms (seek) |
| | Full Stroke CD | 120ms (seek) |
| Maximum Data Transfer Rates | CD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X |
| | DVD ROM Read | DVD+RW Up to 13X DVD-RW Up to 13X DVD+R DL Up to 12X DVD-R DL Up to 12X DVD-ROM Up to 12X DVD-ROM DL Up to 12X |

Technical Specifications – Optical and Removable Storage

| | | |
|--|--|--|
| | | DVD+R Up to 16X DVD-R Up to 16X |
| Power | Source | SATA DC power receptacle |
| | DC Power Requirements | 5 VDC ± 5% -100 mV ripple p-p 12 VDC ± 10% -200 mV ripple p-p |
| | DC Current | 5 VDC <-1500mA typical, <2000 mA maximum. |
| Operating Environmental (all conditions non-condensing) | Temperature | 41° to 122° F (5° to 50° C) |
| | Relative Humidity | 10% to 90% (Non-Condensing) |
| Operating Systems Supported | Windows 11, Windows 10, Windows 7 Professional 64-bit. Red Hat Enterprise Linux WS4**,5,6 Desktop/Workstation. | |
| | No driver is required for this device, Native support is provided by operating system. | |
| Kit Contents | HP SATA DVD Writer drive, Installation guide. | |

HP 9.5mm Slim BDXL Blu-Ray Writer

| | | |
|------------------------------|--|---|
| Description | 9.5mm height, tray-load | |
| Mounting Orientation | Either horizontal or vertical | |
| Interface Type | SATA/ATAPI | |
| Dimensions (WxHxD) | 128 x 9.5 x 127mm | |
| Supported Media Types | BD-ROM BD-R BD-RE DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW | |
| Disc Capacity | DVD-ROM | 8.5 GB DL or 4.7 GB standard |
| | Blu-ray | 25 GB (single-layer) 50 GB (dual-layer) 100/128 GB (BDXL) |
| | Full Stroke DVD | < 230 ms (seek) |
| | Full Stroke CD | < 220 ms (seek) |
| | Blu-ray | < 230 ms (seek) (Full Stroke Blu-ray) |
| | Startup Time | (Time to drive ready from tray loading) |
| | | BD-ROM (SL/DL) 25S / 28S |
| | | BD-R (SL/DL) 25S / 28S |
| | | BD-RE (SL/DL) 25S / 28S |
| | | DVD-ROM (SL/DL) 18S / 18S |
| | | DVD-R (SL/DL) 25S / 25S |
| | | DVD-RW 25S |
| | | DVD+R (SL/DL) 25S / 25S |
| | DVD+RW 25S | |

Technical Specifications – Optical and Removable Storage

| | | | |
|--|--|---|-----|
| | | CD-ROM | 15S |
| Maximum Data Transfer Rates | CD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X | |
| | DVD ROM Read | DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X | |
| | Blu-ray | BD-ROM Up to 6X BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X | |
| Power | Source | SATA DC power receptacle | |
| | DC Power Requirements | 5 VDC ± 5%-100 mV ripple p-p | |
| | DC Current | 5 VDC -900 mA typical, 2000mA maximum | |
| Operating Environmental (all conditions non-condensing) | Temperature | 41° to 122° F (5° to 50° C) | |
| | Relative Humidity | 10% to 80% | |
| | Maximum Wet Bulb Temperature | 84° F (29° C) | |
| Operating Systems Supported | Windows 11, Windows 10, Windows 7 Professional 64-bit Red Hat® Enterprise Linux® (RHEL) 6, 7 Desktop/Workstation SUSE Linux® Enterprise Desktop 12 | | |
| | No driver is required for this device. Native support is provided by the operating system. | | |
| Kit Contents | 9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim SATA data/power cable, installation guide As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation. | | |

| | | |
|--------------------------|------------------------------|--|
| HP SD Card Reader | Description | Supports hardware ECC (Error Correction Code) function Supports hardware CRC (Cyclic Redundancy Check) function Supports SD 4-bit parallel transfer mode |
| | Interface Type | USB 3.1 GEN 1 High-speed interface |
| | Dimensions (WxHxD) | 1.15 x .9 x .15 in (29.00 x 23.6 x 3.15 mm) Fits conveniently in the Front IO Bay |
| | Supported Media Types | Secure Digital Card (SD) Secure Digital High Capacity (SDHC) SD Extended Capacity Memory Card (SDXC) |

Technical Specifications – Optical and Removable Storage

SD Ultra High Speed II(SD UHSII)

These additional media types are supported with a card adapter.

Memory Stick Micro (M2)

miniSD

miniSD High Capacity

Micro SD Memory Card (MicroSD)

Micro SD High Capacity Memory Card (MicroSDHC)

[Test Parameters/Conditions - Power applied, unit operating on system](#)
±5%

Operating Systems Supported

Windows 11, Windows 10

No driver is required for this device. Native support is provided by the operating system.

Kit Contents

Media card reader

Approvals

USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0,
Compliant Intel® Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT

Weight

0.35 lbs. (0.16 kg)

Technical Specifications - Controller Cards

CONTROLLER CARDS

| | | |
|---|--------------------------------------|---|
| HP Thunderbolt-3 Dual Port2 PCIe 1-port I/O Card | Data Transfer Rate | Supports up to 40 Gb/s (40,000 Mb/s) |
| | Devices Supported | Thunderbolt™, Thunderbolt™ 2 and Thunderbolt™ 3 certified for Windows devices |
| | Bus Type | PCIe card, full height PCIe slots |
| | Ports | Two Thunderbolt™ 3 external USB type-C output connectors (Rear) Two full size DisplayPort input connectors (Rear) |
| | Internal Connectors | One 2x5-Pin header connector |
| | System Requirements | Windows 11, Windows 10 Professional, available dedicated PCH PCIe slot. |
| | Temperature - Operating | 50° to 131° F (10° to 55° C) |
| | Temperature - Storage | -22° to 140° F (-30° to 60° C) |
| | Relative Humidity - Operating | 20% to 80% |
| | Compliances | FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC |
| | Operating Systems Supported | Windows 11, Windows 10 Professional. |
| | Kit Contents | HP Thunderbolt™ 3 Dual Port PCIe I/O Card, 2- DisplayPort cables, GPIO (General-Purpose Input/Output) cables, Installation documentation and warranty card. |

*Maximum speed requires DisplayPort™ and PCIe aggregation.

Technical Specifications - Networking and Communications

NETWORKING AND COMMUNICATIONS

| | | |
|---------------------------------|-------------------------------------|--|
| Integrated Intel® I219LM | Connector | RJ-45 |
| | Controller | Intel® I219LM |
| | Data Rates Supported | 10/100/1000 Mbps |
| | Boot ROM Support | PXE, UEFI |
| | Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> • Off = No link • Blinking = Activity Speed LED <ul style="list-style-type: none"> • Off = 10Mbps • Amber = 100Mbps • Green = 1000Mbps |

Management Capabilities Intel® Active Management Technology™ 11

| | | |
|--|-------------------------------------|--|
| Integrated Intel® X722 for 1GbE | Connector | 1 RJ-45 |
| | Controller | Intel® X722 for 1GbE |
| | Data Rates Supported | 1000 Mbps |
| | Boot ROM Support | PXE, UEFI |
| | Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> • Off = No link • Blinking = Activity Speed LED <ul style="list-style-type: none"> • Off = No Link • Green = 1000Mbps |

Management Capabilities Wake-On-LAN

| | | |
|---------------------------------------|---|--|
| HP Z Dual 10GbE Network Module | Networking Interface | 2 RJ-45 |
| | System Interface | Cabled from Dedicated Rear I/O Slot |
| | Networking Speeds Supported | 1Gbps, 10Gbps |
| | Cabling (up to 100m) | Cat5e (or higher) for 1Gbps Cat6a (or higher) for 10Gbps |
| | Power Consumption (active-typical) | 5.5W at 1Gbps 11.2W at 10Gbps |
| | Physical Dimensions | 0.875 in x 3 in x 2.75 in |
| | Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> • Off = No link • Blinking = Activity Speed LED <ul style="list-style-type: none"> • Amber = 1Gbps • Green = 10Gbps |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |

| | | |
|-----------------------|-----------------------------|---------|
| Intel® I210-T1 | Networking Interface | 1 RJ-45 |
|-----------------------|-----------------------------|---------|

Technical Specifications - Networking and Communications

| | |
|---|---|
| System Interface | PCI Express 2.1 x1 |
| Networking Speeds Supported | 10Mbps, 100Mbps, 1Gbps |
| Cabling (up to 100m) | Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps |
| Power Consumption (active-typical) | 0.81W |
| Physical Dimensions | Length: 6.7cm (2.64 inches) (Bracket) Width: 1.8cm (0.709 inches) Full-height end bracket: 12.07cm (4.755 inches) Low-profile end bracket: 8cm (3.15 inches) |
| Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> • Off = No link • Blinking = Activity Speed LED <ul style="list-style-type: none"> • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps |
| Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |
| Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |

| | | |
|-----------------------|---|---|
| Intel® I350-T2 | Networking Interface | 2 RJ-45 |
| | System Interface | PCI Express 2.1 x4 |
| | Networking Speeds Supported | 10Mbps, 100Mbps, 1Gbps |
| | Cabling (up to 100m) | Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps |
| | Power Consumption (active-typical) | 4.4W |
| | Physical Dimensions | Length: 13.54cm (5.33 inches) Width: 6.89 (2.71 inches) Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches) |
| | Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> • Off = No link • Blinking = Activity Speed LED <ul style="list-style-type: none"> • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |

Technical Specifications - Networking and Communications

Hardware Certifications USA: FCC B,
EU: UL CE,
Japan: VCCI,
Taiwan: BSMI,
Australia/New Zealand: CTICK,
Korea: KCC,
Canada: ICES-003/NMB-003

| | | |
|-----------------------|---|---|
| Intel® I350-T4 | Networking Interface | 4 RJ-45 |
| | System Interface | PCI Express 2.1 x4 |
| | Networking Speeds Supported | 10Mbps, 100Mbps, 1Gbps |
| | Cabling (up to 100m) | Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps |
| | Power Consumption (active-typical) | 5W |
| | Physical Dimensions | Length: 13.54cm (5.33 inches) Width: 6.89 (2.71 inches) Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches) |
| | Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> • Off = No link • Blinking = Activity Speed LED <ul style="list-style-type: none"> • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |
| | Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |

| | | |
|--------------------------|---|-------------------------------------|
| Aquantia® AQN-108 | Networking Interface | RJ-45 |
| | System Interface | PCI Express 3 x1 |
| | Networking Speeds Supported | 100Mbps, 1Gbps, 2.5Gbps, 5Gbps |
| | Cabling (up to 100m) | Cat5e (or higher) for all speeds |
| | Power Consumption (active-typical) | 3.5W at 5Gbps, 3.0W at 2.5Gbps |
| | Physical Dimensions | 3.72 in x 3.18 in (without bracket) |

Technical Specifications - Networking and Communications

| | |
|-------------------------------------|--|
| Connect Speed LED Indicators | <p>Link/Activity LED</p> <ul style="list-style-type: none"> • Off = No link • Blinking = Activity <p>Speed LED</p> <ul style="list-style-type: none"> • Off = No link • Amber = <5Gbps • Green = 5Gbps |
| Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |
| Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |

| | |
|-----------------------|---|
| Intel® X550-T2 | <p>Networking Interface</p> <p>2 x RJ-45</p> <p>System Interface</p> <p>PCI Express 3 x4</p> <p>Networking Speeds Supported</p> <p>100Mbps, 1Gbps, 2.5Gbps, 5Gbps, 10Gbps</p> <p>Cabling (up to 100m)</p> <p>Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps Cat6a (or higher) for 10Gbps</p> <p>Power Consumption (active-typical)</p> <p>3.9W at 100Mbps 5.5W at 1Gbps 11.2W at 10Gbps</p> <p>Physical Dimensions</p> <p>5.2 in x 2.7 in (without bracket)</p> <p>Connect Speed LED Indicators</p> <p>Link/Activity LED</p> <ul style="list-style-type: none"> • Off = No link • Blinking = Activity <p>Speed LED</p> <ul style="list-style-type: none"> • Off = No link • Amber = <10Gbps • Green = 10Gbps <p>Operating Temperature</p> <p>0 °C to 55 °C (32 °F to 131 °F)</p> <p>Hardware Certifications</p> <p>USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003</p> |
|-----------------------|---|

| | |
|---|--|
| Allied Telesis AT-2914SX/LC-901 1GB LC Fiber NIC | <p>Network Interface</p> <p>1Gb LC Fiber 850 nm</p> <p>System Interface</p> <p>PCIeG2 x1, Half Height, Half Length</p> <p>Networking Speeds Supported</p> <p>1000Base-X (1Gbps)</p> |
|---|--|

Technical Specifications - Networking and Communications

| | |
|--|---|
| Cabling | 50/125 µm (core/cladding) multimode fiber optic cable up to 500m 62.5/125 µm (core/cladding) multimode fiber optic cable up to 220m |
| Power Consumption (active- typical) | 1.5 Watts |
| Physical Dimensions | 8.8 cm x 6.9 cm (3.5 in x 2.7 in) |
| Connect Speed LED Indicators | ON: 1Gbps Link OFF: Link down |
| Operating Temperature | -25°C to 70°C (-13°F to 158°F) |
| Hardware Certifications | IEEE 802.1p (Quality of Service), IEEE 802.1Q (VLANs), IEEE 802.2 (LLC), IEEE 802.3ac (MAC), IEEE 802.3x (Flow control auto-negotiation), IEEE 802.3z (1000 Base-X), IEEE 802.3ad (Link aggregation) RoHS, UL, FCC/EN55022 Class A, TUV, EN55024, CE, C-TICK, VCCI |

Allied Telesis AT-2911T/2-901

| | |
|---|---|
| Networking Interface | 2 RJ-45 |
| System Interface | PCI Express 3 x1 |
| Networking Speeds Supported | 10Mbps, 100Mbps, 1Gbps |
| Cabling (up to 100m) | Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps |
| Power Consumption (active-typical) | 2.4W |
| Physical Dimensions | Length: 8.8cm (3.5 inches) Width: 6.89 (2.71 inches) Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches) |
| Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> Off = No link Blinking = Activity |
| Operating Temperature | 0 °C to 40 °C (32 °F to 104 °F) |
| Hardware Certifications | USA: FCC B, EU: UL CE, UKCA Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |

Intel® X710-DA2 10GBASE-SR Converged Network Adapter

| | |
|---|--|
| Networking Interface | 2 SFP+ Ports for LC SFP+ Transceivers |
| System Interface | PCI Express 3.0 x8 |
| Networking Speeds Supported | 10Gbps (or 1Gbps with 3 rd party transceiver) |
| Cabling | LC fiber optic cabling with LC SFP+ Transceivers |
| Power Consumption (active-typical) | 4.3W |
| Physical Dimensions | 6.578 in x 2.703 in |

Technical Specifications - Networking and Communications

| | |
|-------------------------------------|---|
| Connect Speed LED Indicators | Link/Activity LED <ul style="list-style-type: none"> • Off = No link • Blinking = Activity Speed LED <ul style="list-style-type: none"> • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps |
| Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |
| Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |

NOTE: Windows 7 is NOT supported

| | | |
|----------------------------------|------------------------------|---|
| 10GbE SFP+ SR Transceiver | Connector Type | LC |
| | Cable Type | 62.5/125um or 50/125um (core/cladding), graded-index, low metal content, multimode fiber optic, complying with ITU-T G.651 and ISO/IEC 793-2 Type A1b or A1a, respectively. |
| | Cable Length | 2-300m |
| | Wavelength | 850nm |
| | Form Factor | SFP+ |
| | Physical Dimensions | 0.47(h) x 0.54(w) x 2.19(d) inches (1.19 x 1.38 x 5.57 cm) |
| | Operating Temperature | 0C to 45C (32F to 113F) |
| | Operating Humidity | 0% to 85%, noncondensing |

| | | |
|---|-----------------------------|---|
| NVIDIA® Mellanox® ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC | Connector | 2 x SFP28 Transceiver Cage (Dual Port)* |
| | Cabling | Depends on transceiver pairing. Typically OM4 or higher MMF LC fiber optic cabling with LC SFP28 Transceivers. |
| | Controller | ConnectX6-DX |
| | Memory | 256Mbit SPI Quad Flash Device |
| | Data Rates Supported | 1/10/25GbE |
| | Compliance | <ul style="list-style-type: none"> – IEEE 802.3by 25 Gigabit Ethernet – IEEE 802.3ae 10 Gigabit Ethernet – IEEE 802.3ap based auto-negotiation and KR startup – IEEE 802.3ad, 802.1AX Link Aggregation – IEEE 802.1Q, 802.1P VLAN tags and priority – IEEE 802.1Qau (QCN) – Congestion Notification – IEEE 802.1Qaz (ETS) – IEEE 802.1Qbb (PFC) – IEEE 802.1Qbg – IEEE 1588v2 – Jumbo frame support (9.6KB) |

Technical Specifications - Networking and Communications

| | |
|------------------------------|---|
| | <ul style="list-style-type: none"> – Safety: CB/cTUVus/CE – EMC: CE/FCC/VCCI/ICES/RCM – RoHS Compliant |
| Bus Architecture | PCIe Gen 4 x8 |
| Data Transfer Mode | PCI Express - stores and accesses Ethernet fabric connection information and packet data |
| Power Requirements | 11.5 Watts (typical) |
| Network Transfer Rate | 1Gbps, 10Gbps, 25Gbps |

NOTE: Network Transfer Rate depends on transceiver model.*

Kit Contents NVIDIA® Mellanox® ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC

*Transceivers sold separately. You must have a transceiver installed in order to connect this card to a network.

| | | |
|-------------------------|---------------------------|--|
| Intel® 8265 WLAN | Networking Speeds | 802.11ac MU-MIMO (up to 867 Mbps) Bluetooth 4.2 |
| | IEEE WLAN Standard | IEEE 802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w; 802.11r, 802.11k, 802.11v pending |
| | Bluetooth | 4.2 |
| | System Interface | PCI Express 2.1 x1 |
| | Antenna | 2x2 |

Summary of Changes

SUMMARY OF CHANGES

| Date of change: | Version History: | | Description of change: |
|--------------------|------------------|---------|---|
| November 1, 2017 | From v1 to v2 | Added | HP DisplayPort to HDMI Adapter, HP DisplayPort to VGA Adapter, NVIDIA SLI 3-slot Graphics Connector and NVIDIA Quadro Sync II to Graphics section and Microsemi 3152-8i SAS ROC RAID Controller |
| | | Changed | Graphics, Storage / Hard Drives and Memory sections, changed Front and internal view info on the Overview section, changed Operating Systems section, changed System Board section, Physical Security and Serviceability sections |
| November 29, 2017 | From v2 to v3 | Added | Processors, hard drives and graphics to offerings, added Declared Noise Emissions information |
| January 30, 2018 | From v3 to v4 | Removed | NVIDIA SLI Graphics Connectors from Graphics Cable Adapters section |
| March 27, 2018 | From v4 to v5 | Added | Intel Xeon processors added |
| April 16, 2018 | From v5 to v6 | Removed | RAID 5 |
| August 13, 2018 | From v6 to v7 | Added | Footnote to Networking and Communications section |
| | | Changed | Processors section and Operating Systems section |
| September 4, 2018 | From v7 to v8 | Removed | HP IEEE 1394b FireWire PCIe Card |
| September 6, 2018 | From v8 to v9 | Removed | Microsemi 3152-8i SAS ROC RAID Controller |
| September 21, 2018 | From v9 to v10 | Added | Intel Optane SSD 905p AiC 280GB & 480GB |
| September 26, 2018 | From v10 to v11 | Changed | NVIDIA Quadro P6000 Graphics specs |
| April 8, 2019 | From v11 to v12 | Added | New Intel Xeon Processors and graphics, added HP DX175 Removable HDD Carrier into the HDD Frame/Carriers section |
| | | Changed | Storage / Hard Drives, Memory sections and format changes |
| May 15, 2019 | From v12 to v13 | Added | NVIDIA Quadro RTX 8000 48GB Graphics |
| | | Changed | External BIOS simulator link on Physical Security and Serviceability section |
| | | Removed | Intel 9260 WLAN |
| June 12, 2019 | From v13 to v14 | Changed | Storage section |
| July 7, 2019 | From v14 to v15 | Added | Intel Xeon W Processors |
| July 15, 2019 | From v15 to v16 | Changed | Corrected Intel 905p Series AiC 480GB PCIe SSD |
| August 1, 2019 | From v16 to v17 | Changed | Processors Matrix |
| September 1, 2019 | From v17 to v18 | Added | Footnote to Memory section, Added Optane 905P 380GB M.2 SSD Module, HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Kit & module to Storage section, Added Intel® Wi-Fi 6 AX200 & BT PCIe to Networking section |
| October 26, 2019 | From v18 to v19 | Changed | Graphics section |
| November 1, 2019 | From v19 to v20 | Added | NVDIMM Memory sections, Added HP QX310 Removable NVMe Frame/Carrier w/PCIe card to Optical and Removable Storage section |
| January 2, 2020 | From v20 to v21 | Changed | Storage section |
| February 26, 2020 | From v21 to v22 | Added | New Intel Xeon Processors |
| | | Changed | Overview, PCIe Solid State Drives sections |
| April 2, 2020 | From v22 to v23 | Changed | Processors and NVDIMM Memory sections |
| July 18, 2020 | From v23 to v24 | Changed | Processors, Graphics section |
| January 5, 2021 | From v24 to v25 | Changed | Processors, Memory, Graphics, Racking and Physical Security, Operating Systems and Hard Drives sections |
| February 1, 2021 | From v25 to v26 | Changed | NETWORKING AND COMMUNICATIONS section |
| March 1, 2021 | From v26 to v27 | Changed | Overview section |
| April 13, 2021 | From v27 to v28 | Changed | Processors, Graphics and Social and Environmental Responsibility sections |
| May 1, 2021 | From v28 to v29 | Changed | Graphics section |
| June 1, 2021 | From v29 to v30 | Changed | Memory and Graphics sections |
| July 1, 2021 | From v30 to v31 | Changed | Graphics section |
| August 1, 2021 | From v31 to v32 | Changed | Graphics section |
| September 1, 2021 | From v32 to v33 | Changed | Input Devices and Graphics sections |
| October 1, 2021 | From v33 to v34 | Changed | Graphics and System Board sections |

Summary of Changes

| | | | |
|-------------------|-----------------|---------|---|
| November 1, 2021 | From v34 to v35 | Changed | Processors and Graphics sections |
| December 1, 2021 | From v35 to v36 | Changed | Operating Systems, Graphics, Networking and Communications and Input Devices sections |
| December 15, 2021 | From v36 to v37 | Changed | OPERATING SYSTEM and Social and Environmental Responsibility sections |
| January 1, 2022 | From v37 to v38 | Changed | Graphics, OPERATING SYSTEM and Application Software sections |
| February 1, 2022 | From v38 to v39 | Changed | Input Devices section |
| March 1, 2022 | From v39 to v40 | Changed | Graphics, Social and Environmental Responsibility sections |
| April 1, 2022 | From v40 to v41 | Changed | Processors, Graphics and Stable & Consistent Offerings sections |
| May 2, 2022 | From v41 to v42 | Changed | Graphics section |
| June 1, 2022 | From v42 to v43 | Changed | Graphics, Networking and Communications sections |
| July 1, 2022 | From v43 to v44 | Changed | Graphics section |
| August 1, 2022 | From v44 to v45 | Changed | NETWORKING AND COMMUNICATIONS section |
| September 1, 2022 | From v45 to v46 | Changed | Format page 18 |
| October 1, 2022 | From v46 to v47 | Changed | Graphics section |
| December 1, 2022 | From v47 to v48 | Changed | Input Devices section |
| December 9, 2022 | From v48 to v49 | Changed | Optical and Removable Storage section |
| January 1, 2023 | From v49 to v50 | Changed | Networking and Communications, GRAPHICS sections |
| February 1, 2023 | From v50 to v51 | Changed | Other Hardware section |
| March 1, 2023 | From v51 to v52 | Changed | Manageability section |
| April 1, 2023 | From v52 to v53 | Changed | Processors and Graphics sections |
| May 1, 2023 | From v53 to v54 | Changed | Other Hardware section |
| June 1, 2023 | From v54 to v55 | Changed | Graphics section |
| July 1, 2023 | From v55 to v56 | Changed | Networking and Communications, Other Hardware sections |
| August 1, 2023 | From v56 to v57 | Changed | Social and Environmental Responsibility section |

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